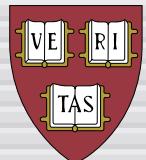


# **Femtosecond Laser Micromachining**

**Sam Chung  
Raffael Gattass  
Iva Maxwell  
Jonathan Ashcom  
Chris Schaffer  
Limin Tong**

**Eli Glezer  
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Philip LeDuc  
Sam Aravi  
Donald E. Ingber**



# Introduction

## Laser-Induced Electric Breakdown in Solids

NICOLAAS BLOEMBERGEN, FELLOW, IEEE

**A**bstract—A review is given of recent experimental results on laser-induced electric breakdown in transparent optical solid materials. A fundamental breakdown threshold exists characteristic for each material. A threshold is determined by the same physical process for each material. The namely, avalanche ionization. The dependence of the threshold on laser pulse duration and frequency is consistent with this process. The implication of this breakdown mechanism for laser bulk and surface damage, the implication components is discussed. It also determines physical properties of self-focused filaments.

### I. INTRODUCTION

THE history of laser-induced electric breakdown is almost as old as the history of lasers itself. Early in 1963 Maker *et al.* [1] reported damage to transparent dielectrics and the production of a spark in air by focusing a pulsed ruby laser beam. The importance of these early experiments for the production of laser-induced dense

plasmas and for the propagation characteristics of high-power laser beams through solids, liquids, and gases was quickly recognized. The subject of electric breakdown in transparent optical solids, including laser materials, windows, and other optical components, remained, until recently, largely an empirical or engineering science. Although a vast amount of theoretical and experimental effort was expended in the economically and technically important problem of optical damage, quantitatively reproducible breakdown thresholds with unambiguous theoretical interpretations have been obtained only during the last two years. The situation was somewhat analogous to the development of our understanding of the problem of dc breakdown in electrical insulators. There, too, the field developed largely by engineering trial and error. Basic quantitative understanding was not achieved until reproducible experimental results on well-defined materials were obtained [2]. The difficulties in dc breakdown experiments were manifold: the influence of space charges, the occurrence of space charges due

# Introduction

## Laser-Induced Electric Breakdown in Solids

NICOLAS BLOembergen, MIT, Cambridge, Massachusetts

Three reviews are given of recent experimental results on laser-induced electric breakdown in transparent optical solid materials. A threshold is determined as the same physical process as in breakdown, namely, avalanche ionization. The dependence of the threshold on laser pulse intensity and frequency is consistent with this process. The implication of this breakdown mechanism for laser bulk and surface damage in optical components is discussed. It also determines physical properties of self-lensed filaments.

### Introduction

The history of laser-induced electric breakdown damage in transparent dielectrics and the production of nanometer-sized holes by laser beam. The importance of these effects in the production of laser-induced lenses

depends not for the propagation characteristics of high-power laser beam through solids. Rapid and successive breakdown is observed. The effect of electric breakdown in transparent optical solids, including laser materials, waveguides, and other optical components, remained until recently, largely unexplored. In optical engineering science, significant work began in theoretical and experimental optics was expended in the economic and technical important problem of optical damage. An indispensable reproducible breakdown thresholds with unambiguous theoretical interpretation have been observed only during the last two years. The situation was somewhat analogous to the development of our understanding of the problem of the development of electrical insulators. Therefore, the field developed largely by geometrical (1) and statistical (2) methods. The understanding was not enhanced until basic quantitative results on well-defined experimental experiments were obtained (3). The difficulties in dielectric materials were manifold: the influence of laser beam on the occurrence of space charge effects or beam de-

# *Introduction*

DAMAGED

22nd ANNUAL BOULDER DAMAGE SYMPOSIUM  
Proceedings



LASER-INDUCED DAMAGE  
IN OPTICAL MATERIALS: 1990

24-26 OCTOBER 1990  
BOULDER, COLORADO

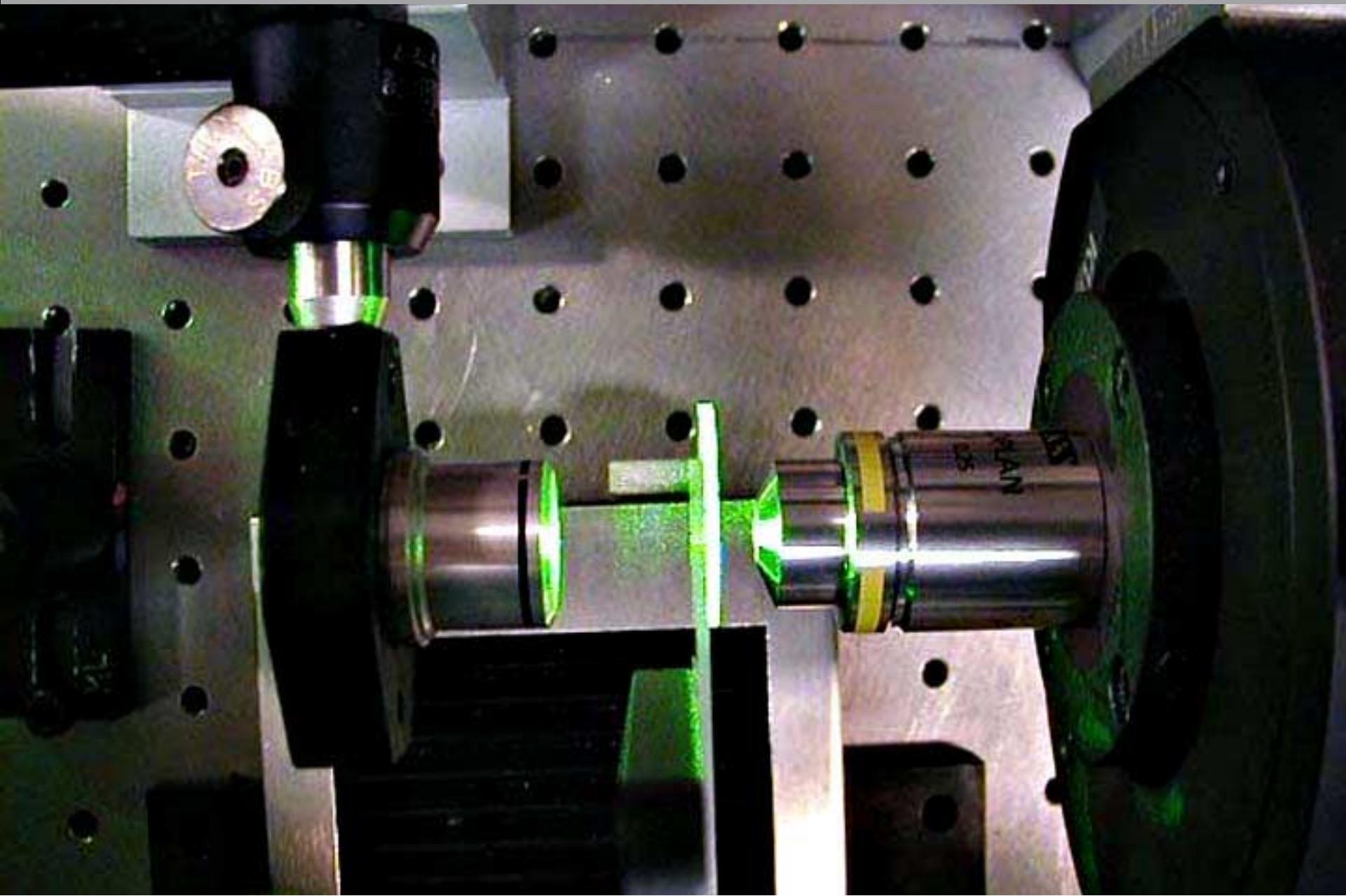
STP 1141

## *Introduction*



**use 'damage' for processing!**

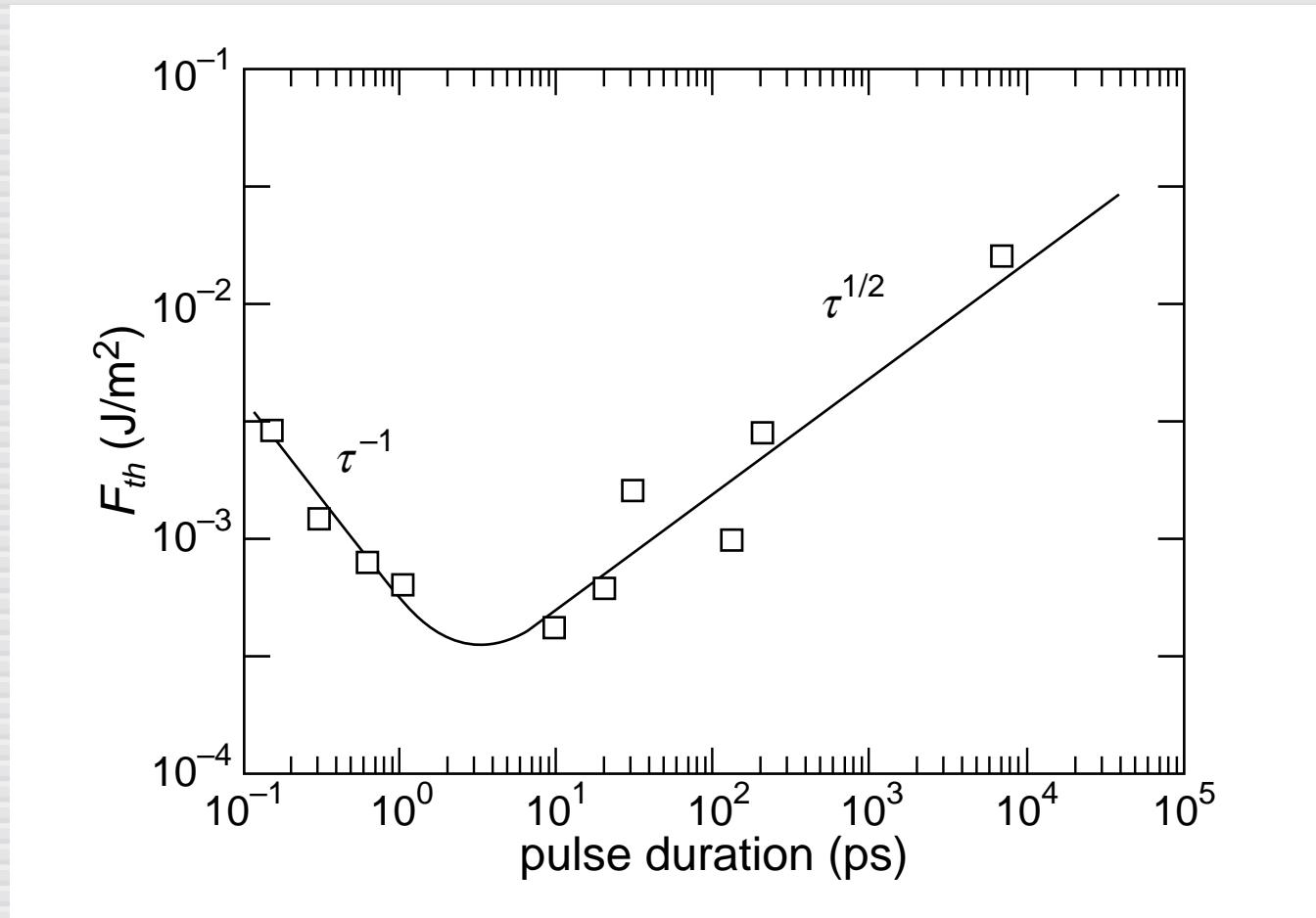
# *Outline*



## *Outline*

- ▶ Processing with fs pulses
- ▶ Role of focusing
- ▶ Low-energy processing

## *Processing with fs pulses*



# *Processing with fs pulses*

216 J. Opt. Soc. Am. B/Vol. 13, No. 1/January 1996

D. von der Linde and H. Schäfer

## **Breakdown threshold and plasma formation in femtosecond laser-solid interaction**

D. von der Linde and H. Schäfer

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Received March 6, 1995; revised manuscript received June 15, 1995

Combining femtosecond pump-probe techniques with optical microscopy, we have studied laser-induced optical breakdown in optically transparent solids with high temporal and spatial resolution. The threshold of plasma formation has been determined from measurements of the changes of the optical reflectivity associated with the developing plasma. It is shown that plasma generation occurs at the surface. We have observed a remarkable resistance to optical breakdown and material damage in the interaction of femtosecond laser pulses with bulk optical materials. © 1996 Optical Society of America

### **1. INTRODUCTION**

The interaction of intense femtosecond laser pulses with solids offers the possibility of producing a new class of plasmas having approximately solid-state density and spatial density scale lengths much smaller than the wavelength of light. These high-density plasmas with extremely sharp density gradients are currently of great interest, particularly from the point of view of generating short x-ray pulses. To produce such a plasma, the field rise from the intensity level of the laser pulse to the plasma formation time scale

and his co-workers was the use of very tightly focused laser beams, which allowed them to reach the breakdown threshold of the materials while staying well below the critical power of self-focusing. Self-focusing is one of the major problems in the measurement of bulk breakdown thresholds. In a more recent review Soileau *et al.*<sup>5</sup> carefully examined the role of self-focusing in experiments measuring laser-induced breakdown of bulk dielectric materials. They concluded that the breakdown and damage thresholds are also strongly influenced by extrinsic effects.

Thus far, the issue of breakdown thresholds in femtosecond laser-solid interaction has barely been touched. Recently, Du *et al.*<sup>6</sup> carried out laser-induced breakdown on fused silica with pulses ranging in energy as low as 150 fs. They reported a space threshold of the

# *Processing with fs pulses*

**"... clear evidence that no bulk plasmas ...  
[and] ... no bulk damage could be produced  
with femtosecond laser pulses."**

## 1. INTRODUCTION

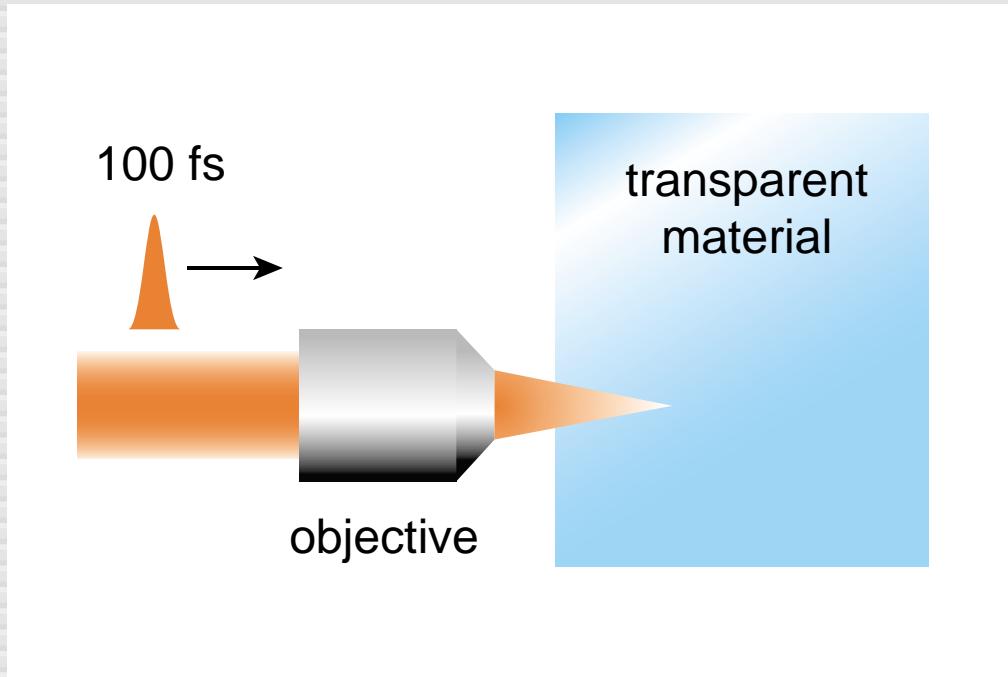
The interaction of intense femtosecond laser pulses with solids offers the possibility of producing a new class of plasmas having approximately solid-state density and length of mean free path, but lengths much smaller than the wavelength of the incident light. To produce such high-density plasmas with extremely short x-ray pulses, particularly from the point of view of great intensity, is currently of great interest.

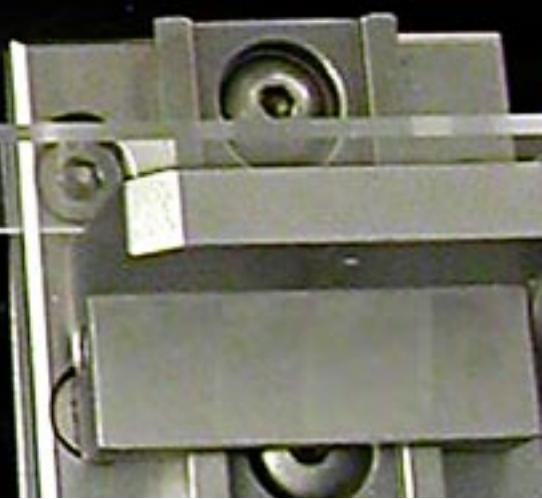
One of the key points in the research of Bloemberger and his co-workers was the use of very tightly focused laser beams, which allowed them to reach the breakdown threshold of the materials while staying well below the critical power of self-focusing. Self-focusing is one of the major problems in the measurement of bulk breakdown thresholds. In a more recent review Soileau *et al.* carefully examined the role of self-focusing in experiments measuring laser-induced breakdown of bulk dielectric materials. They concluded that the breakdown and damage thresholds are also strongly influenced by extrinsic effects.

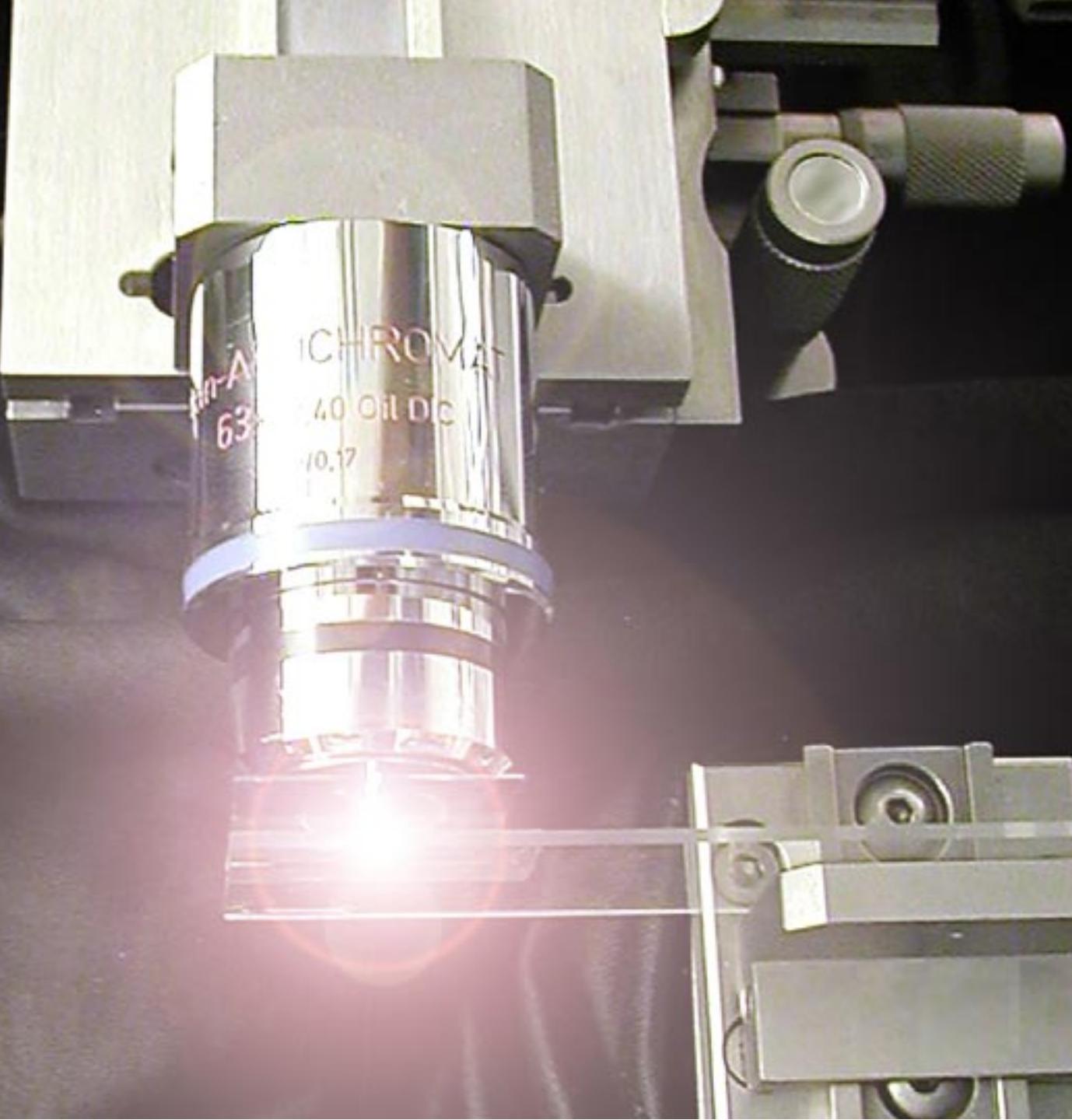
Thus far, the issue of breakdown thresholds in femtosecond laser-solid interaction has barely been touched. Do *et al.*<sup>1</sup> carried out laser-induced breakdown on fused silica with pulses ranging in duration from 100 fs to as long as 150 fs. They reported

# *Processing with fs pulses*

**focus laser beam inside material**





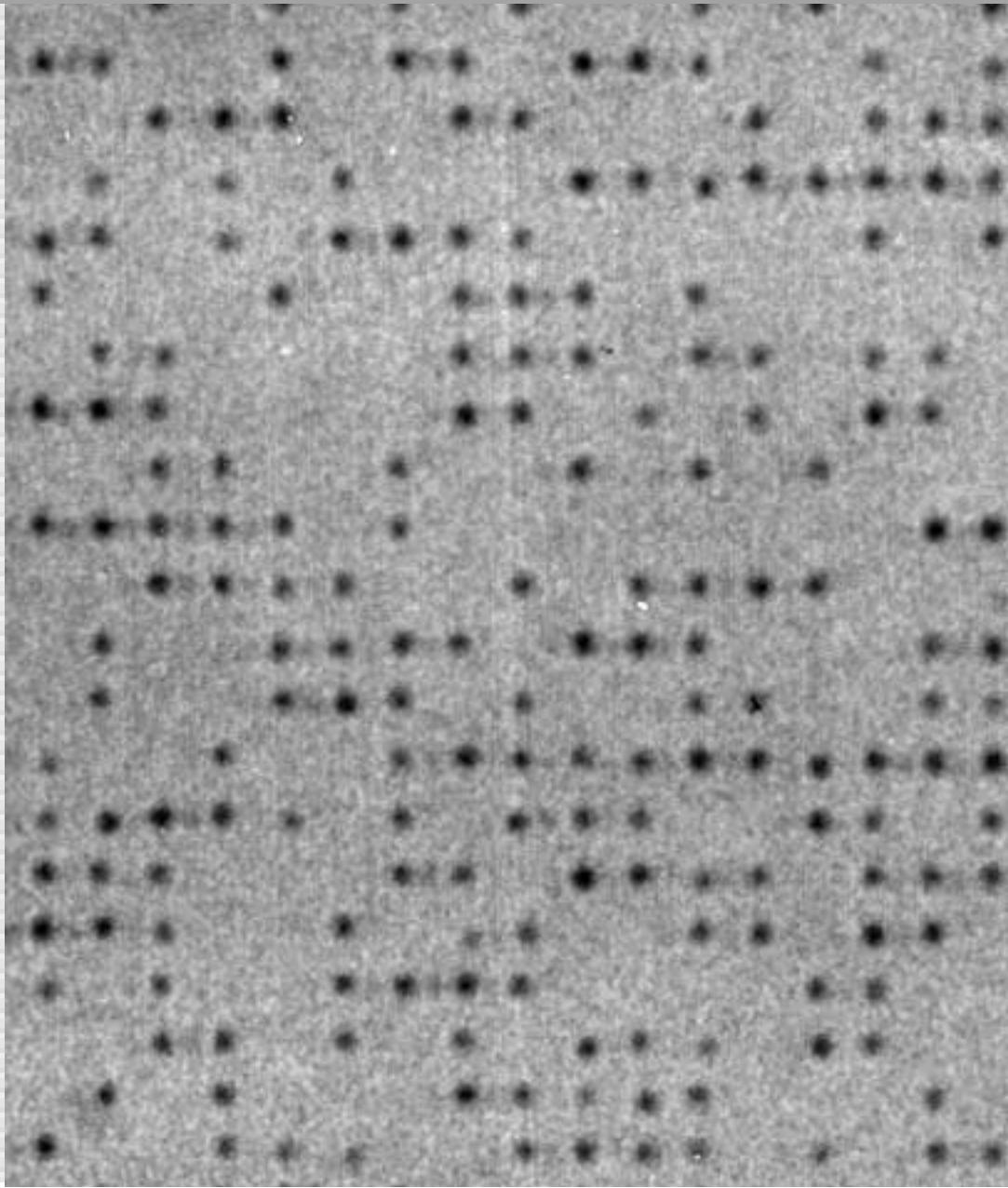


## *Processing with fs pulses*

**2 x 2  $\mu\text{m}$  array**

**fused silica, 0.65 NA**

**0.5  $\mu\text{J}$ , 100 fs, 800 nm**

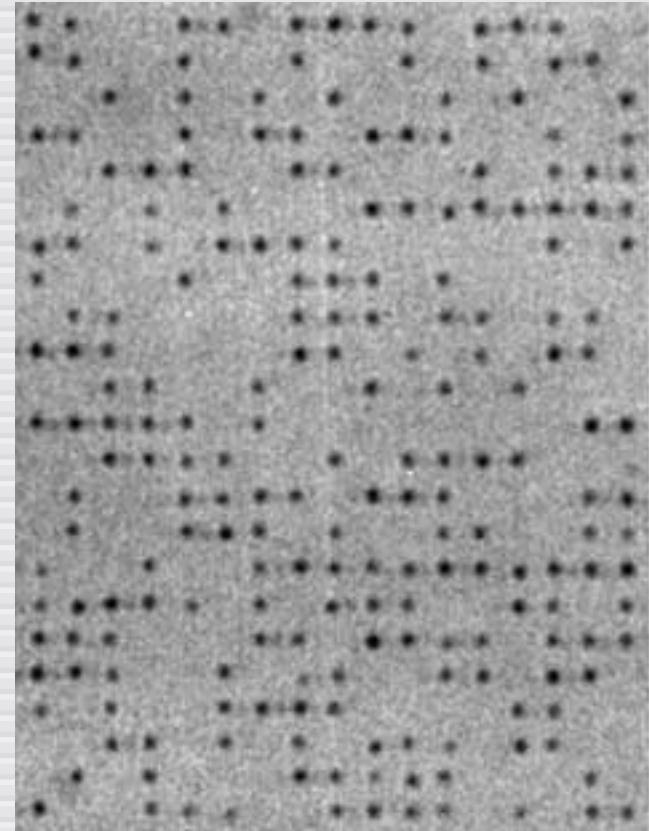


## *Processing with fs pulses*

**2 x 2  $\mu\text{m}$  array**

**fused silica, 0.65 NA**

**0.5  $\mu\text{J}$ , 100 fs, 800 nm**

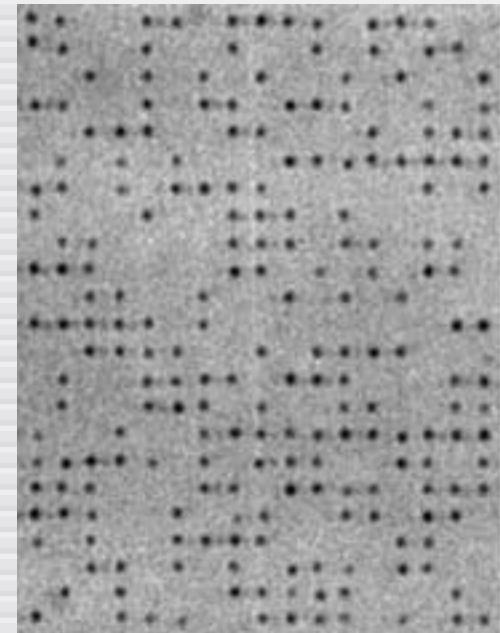


## *Processing with fs pulses*

**2 x 2  $\mu\text{m}$  array**

**fused silica, 0.65 NA**

**0.5  $\mu\text{J}$ , 100 fs, 800 nm**

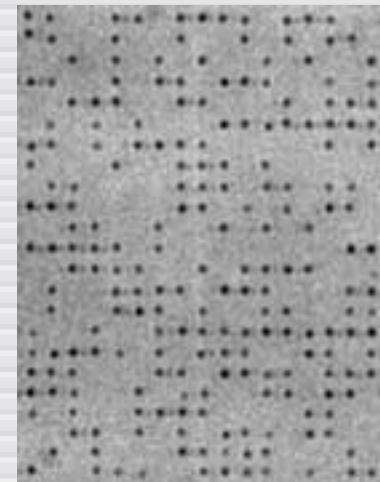


## *Processing with fs pulses*

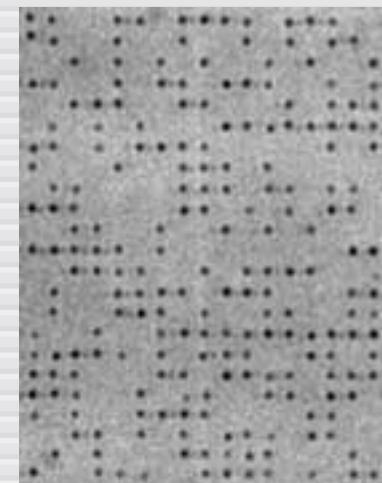
**2 x 2  $\mu\text{m}$  array**

**fused silica, 0.65 NA**

**0.5  $\mu\text{J}$ , 100 fs, 800 nm**



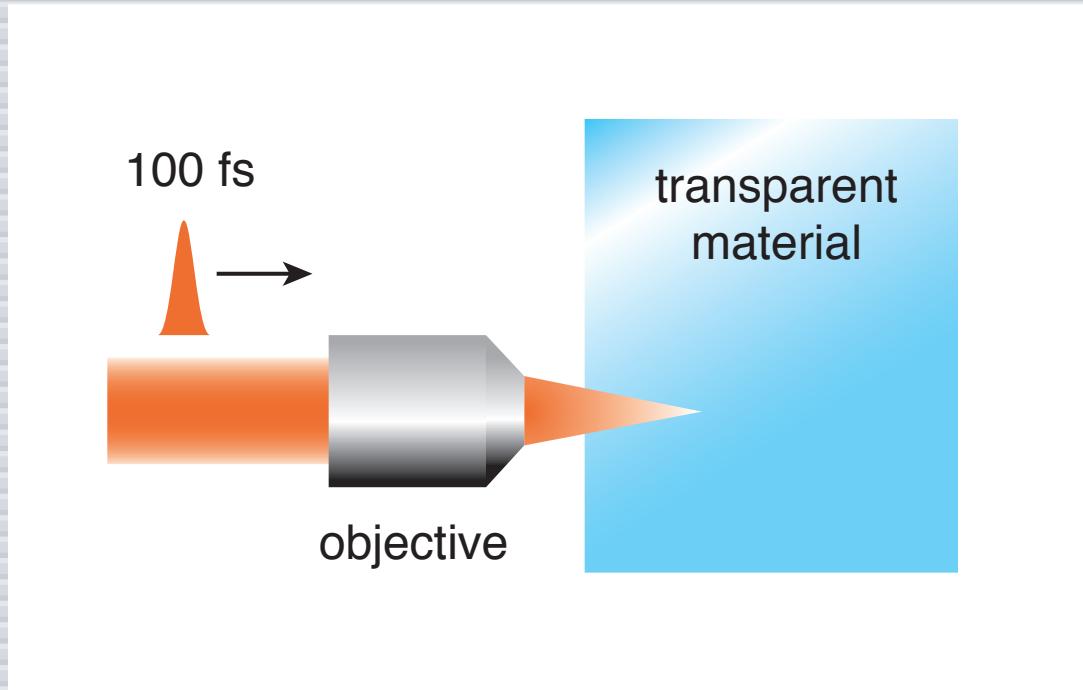
## *Processing with fs pulses*



**100 fs  
0.5 μJ**

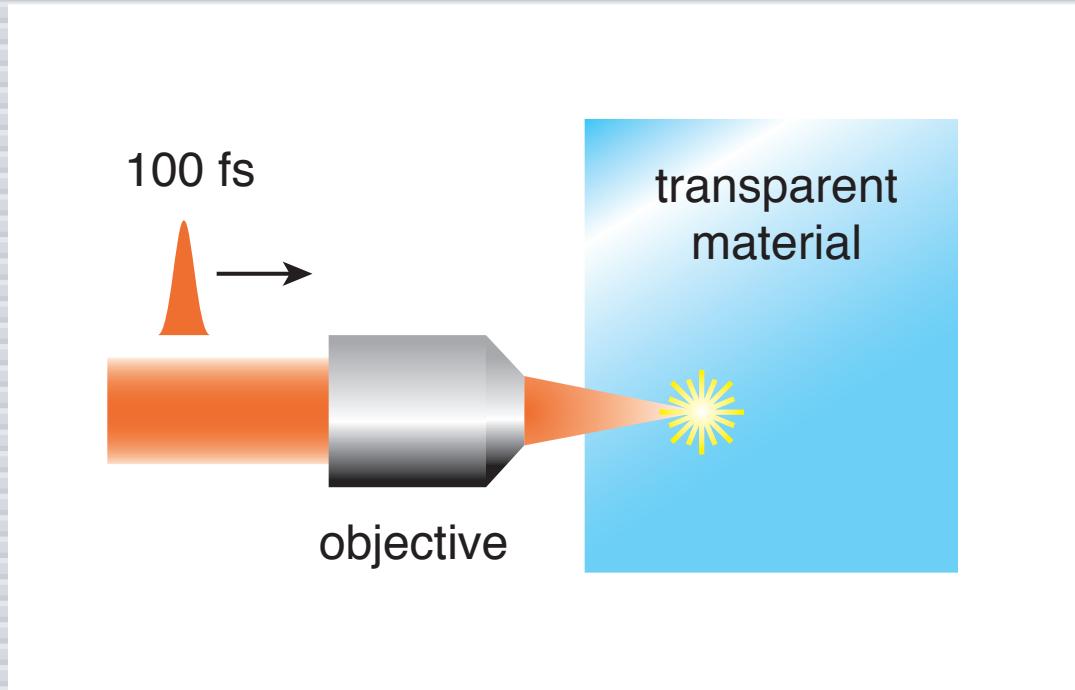
**200 ps  
9 μJ**

## *Processing with fs pulses*



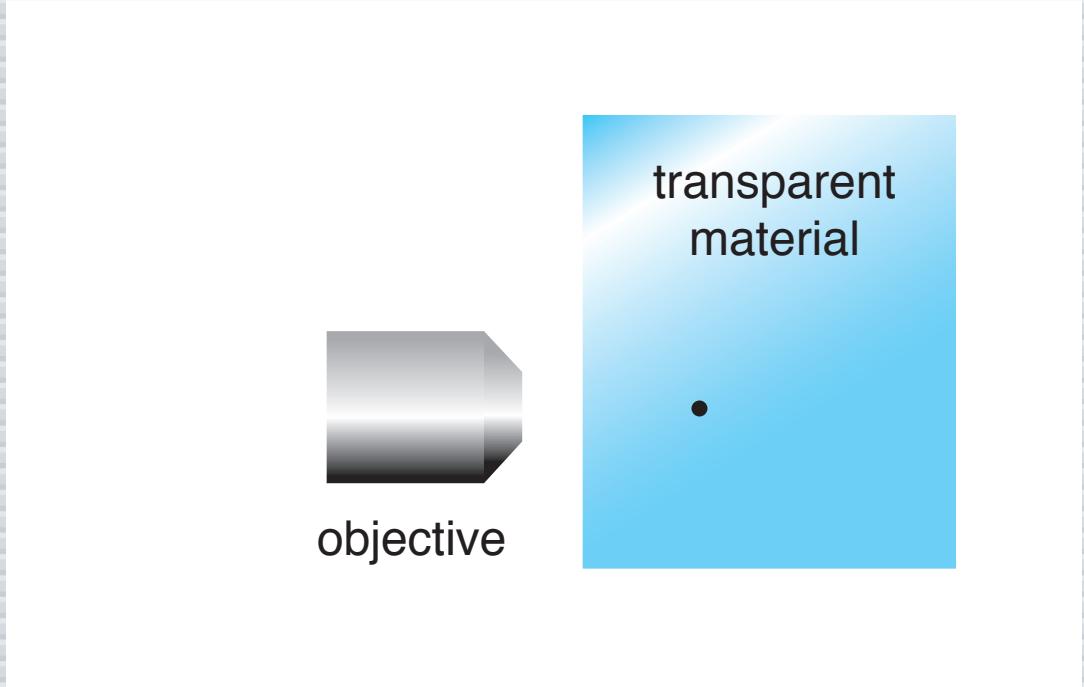
**high intensity at focus...**

## *Processing with fs pulses*



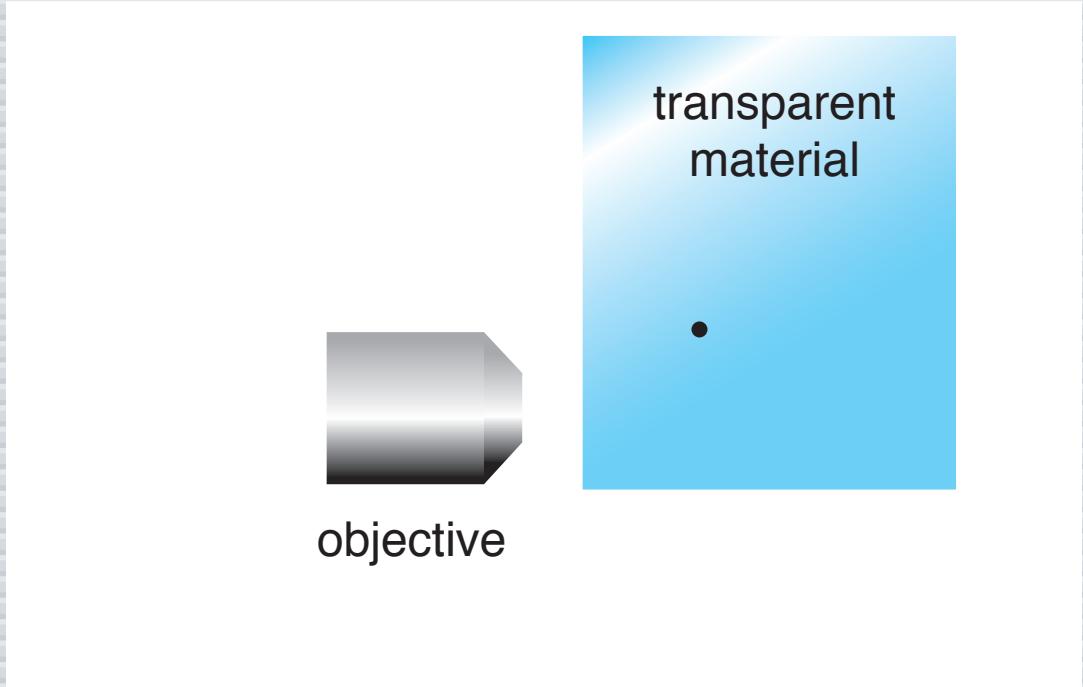
**...causes nonlinear ionization...**

## *Processing with fs pulses*



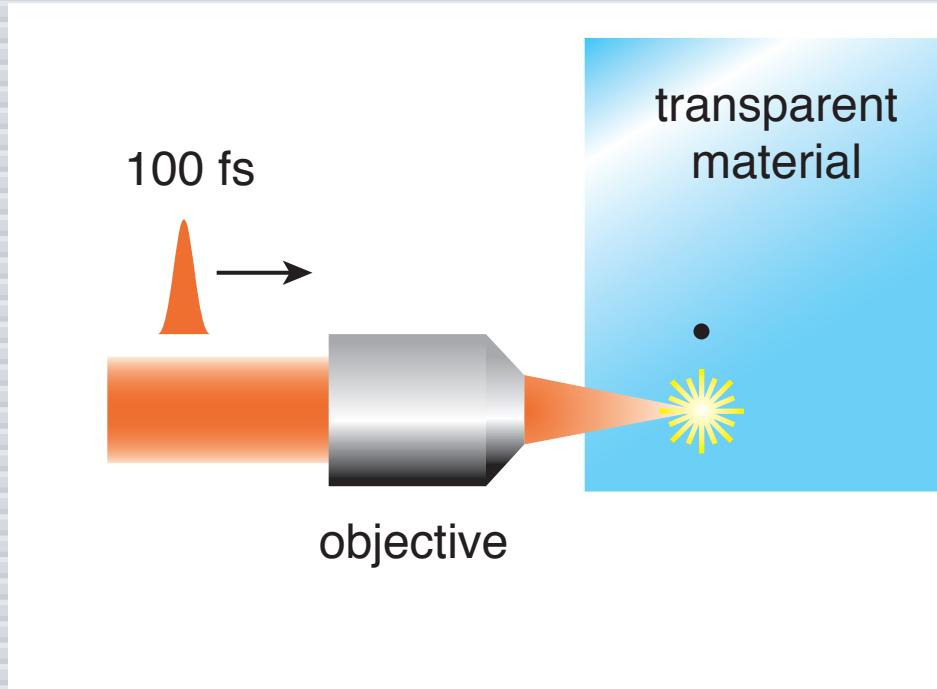
**and 'microexplosion' causes microscopic damage**

# *Processing with fs pulses*



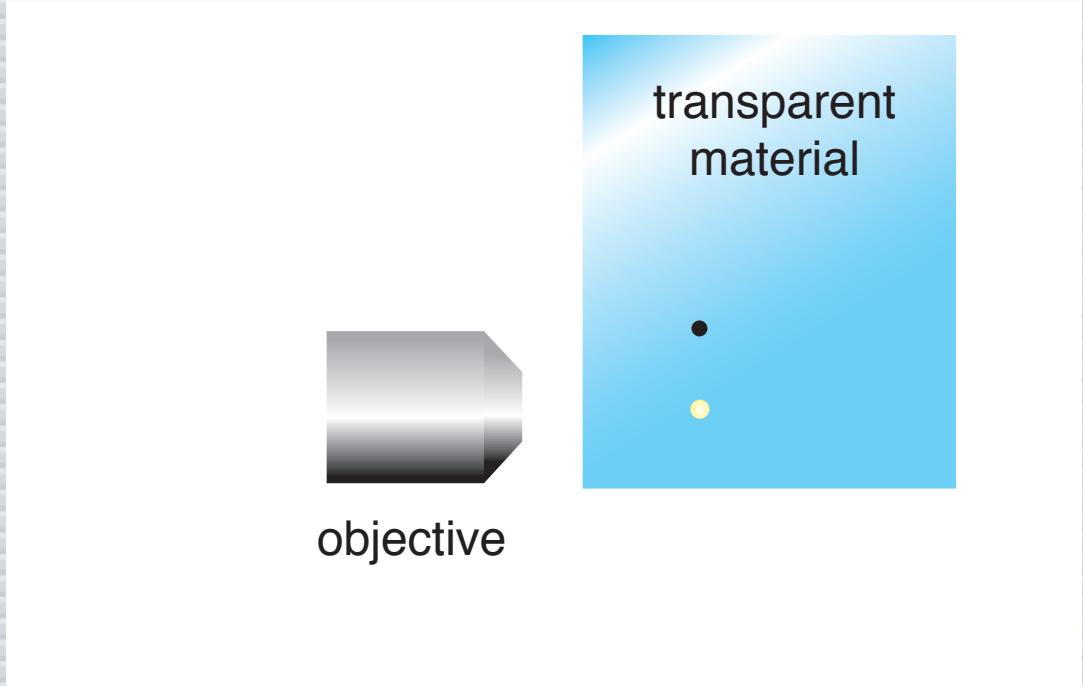
**translate sample**

## *Processing with fs pulses*



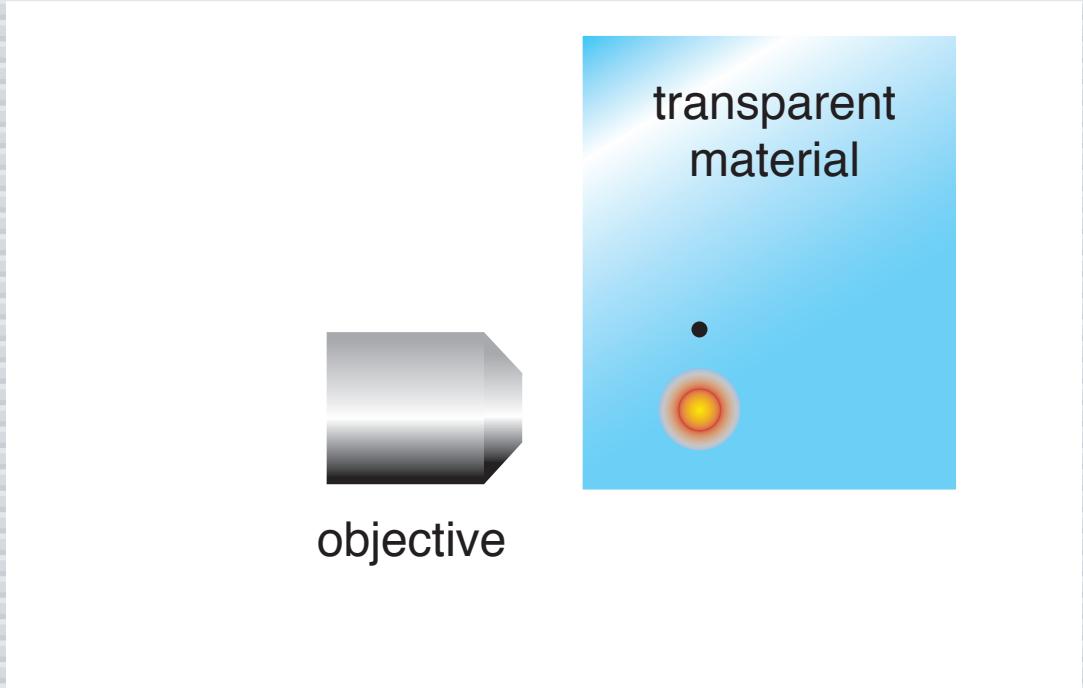
**100 fs: laser energy transferred to electrons**

## *Processing with fs pulses*



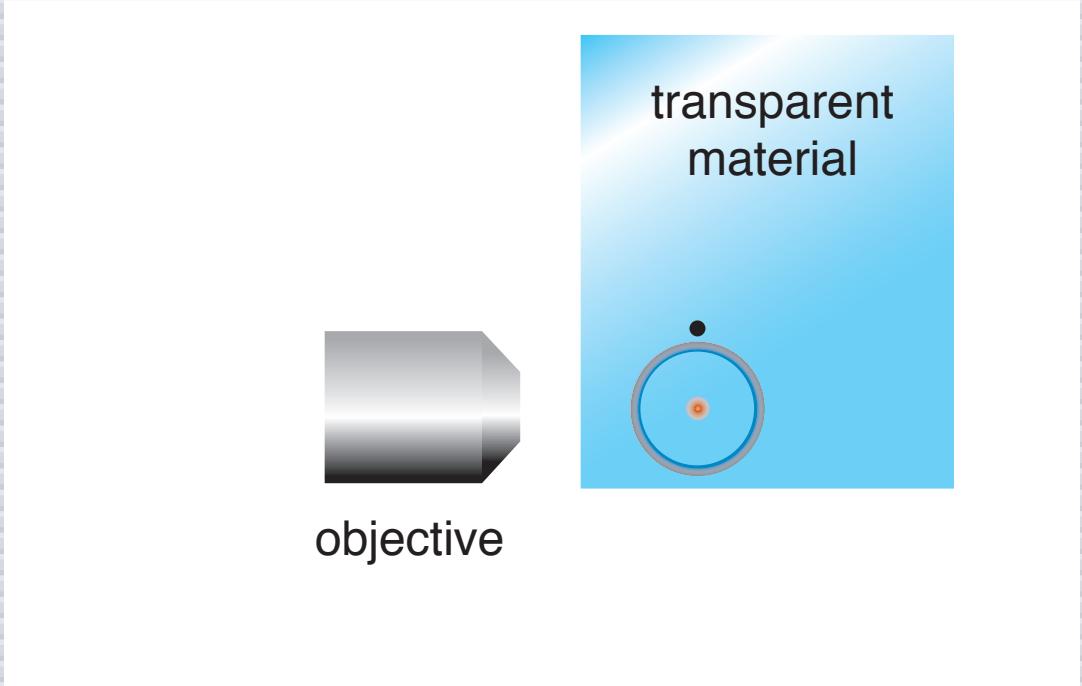
**10 ps: energy transfer to ions**

## *Processing with fs pulses*



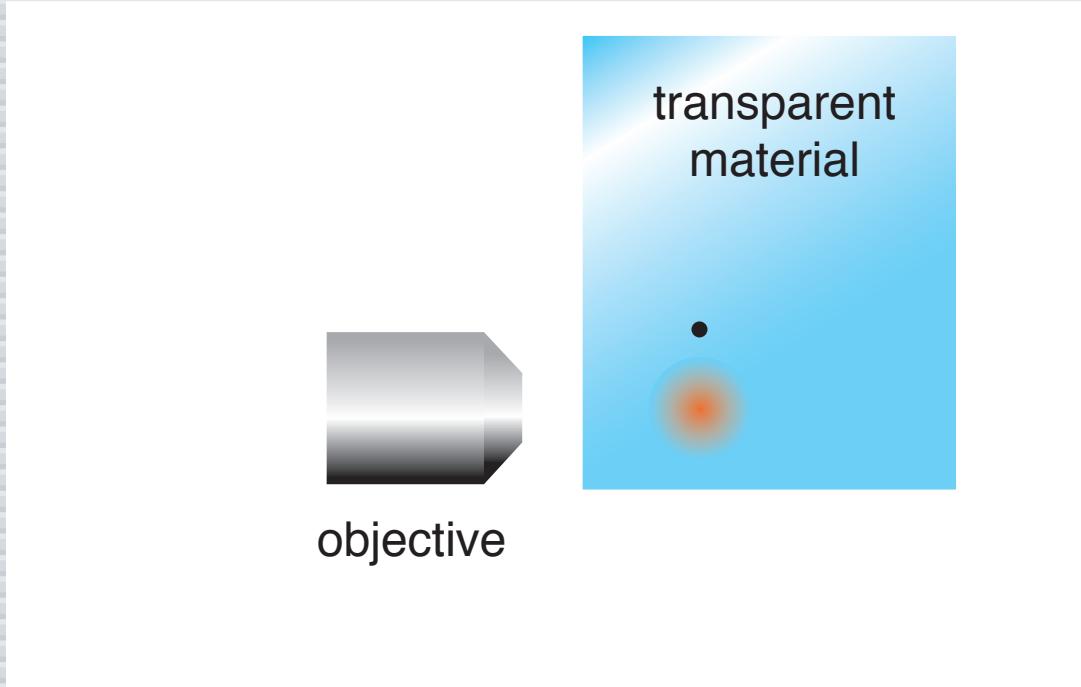
**100 ps: plasma expansion**

## *Processing with fs pulses*



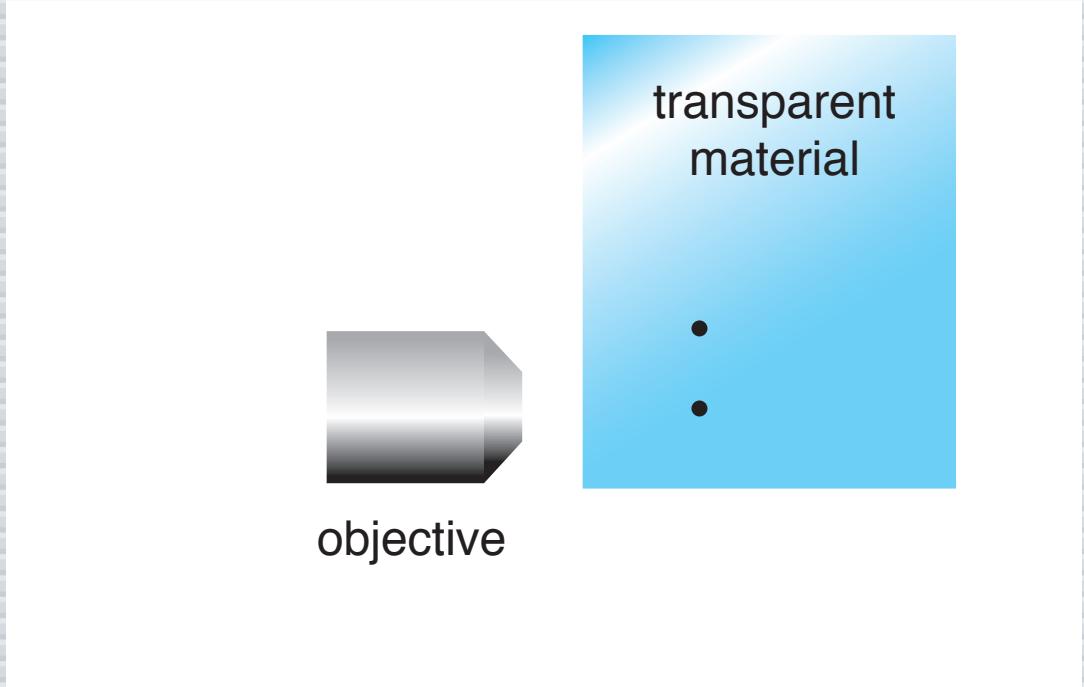
**10–100 ns: shock propagation**

# *Processing with fs pulses*



**1  $\mu$ s: thermal expansion**

## *Processing with fs pulses*



**1 ms: permanent structural damage**

## *Processing with fs pulses*

### Points to keep in mind:

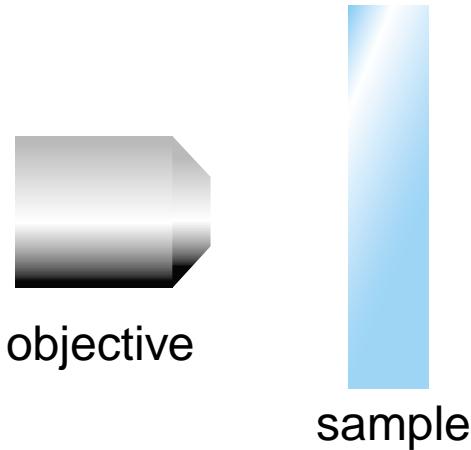
- ▶ **fs laser processing works**
- ▶ **focusing very important**
- ▶ **no collateral damage**

# *Outline*

- ▶ Processing with fs pulses
- ▶ Role of focusing
- ▶ Low-energy processing

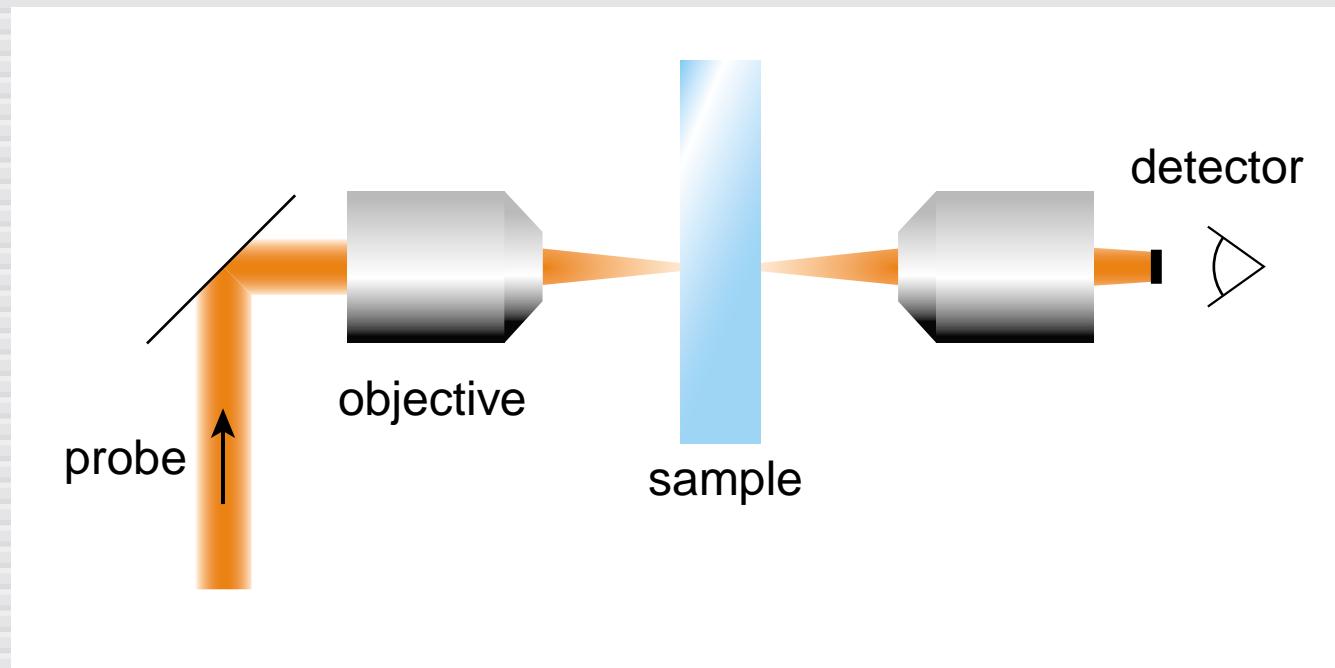
## *Role of focusing*

### **Dark-field scattering**



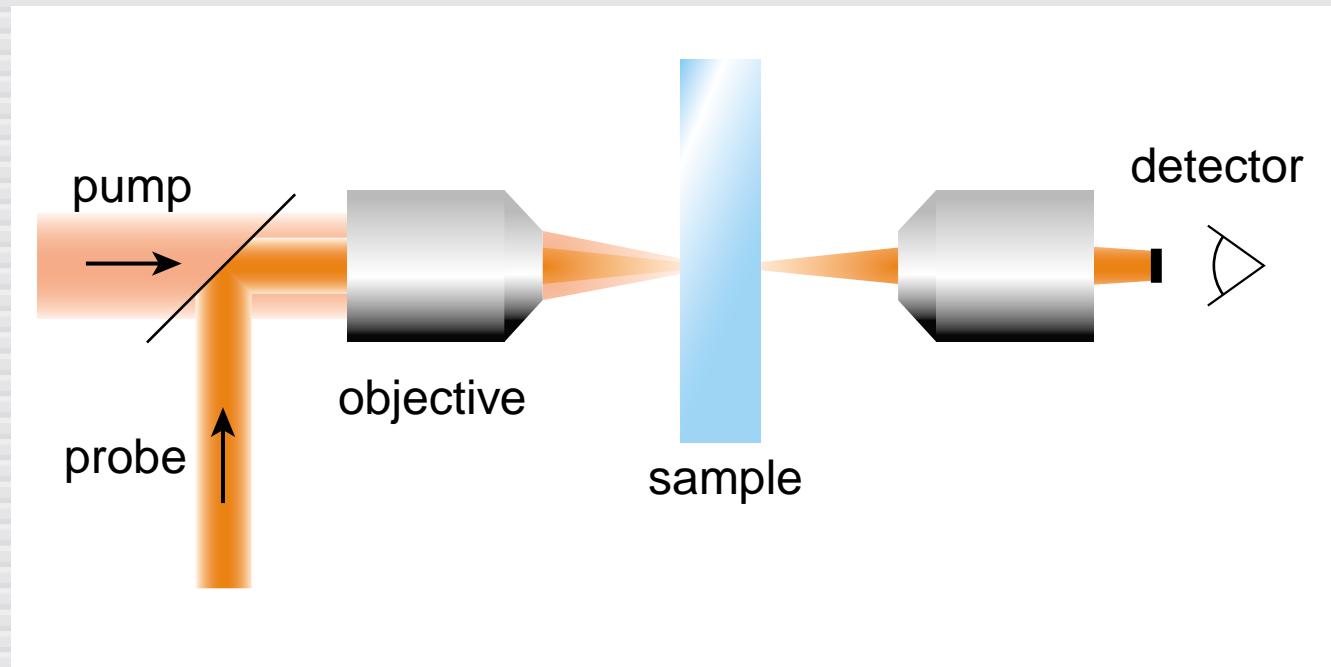
## *Role of focusing*

**block probe beam...**



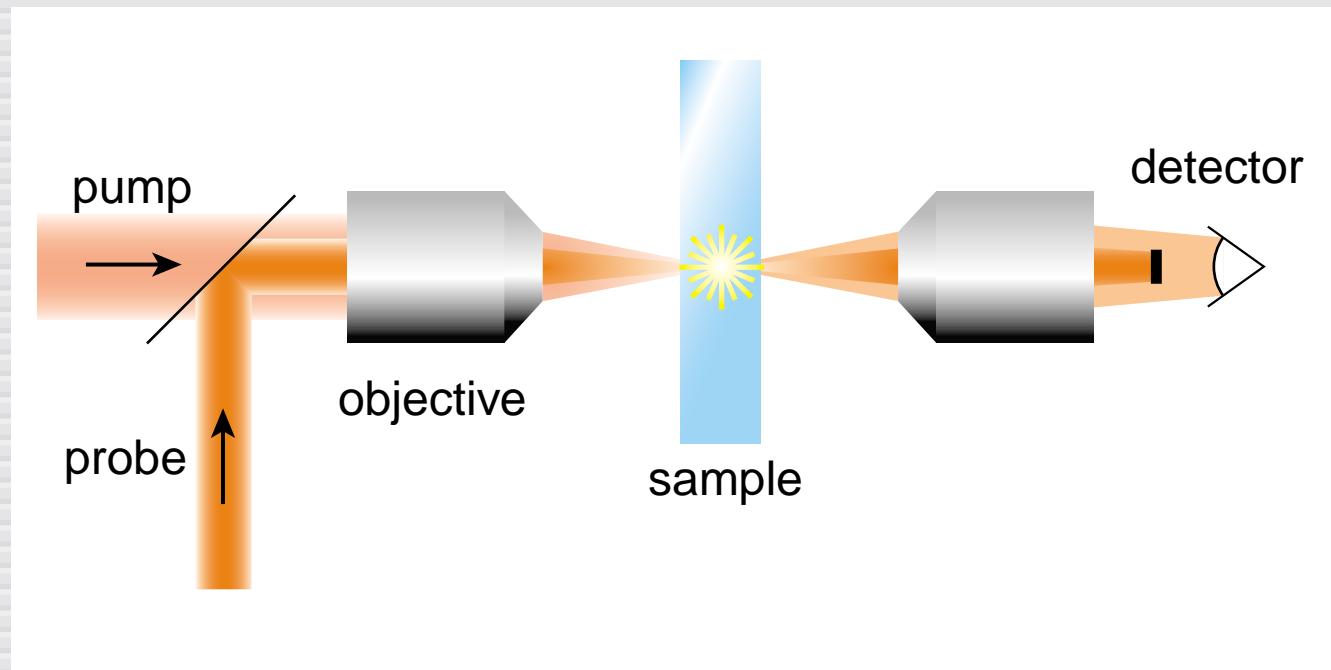
# *Role of focusing*

... bring in pump beam...

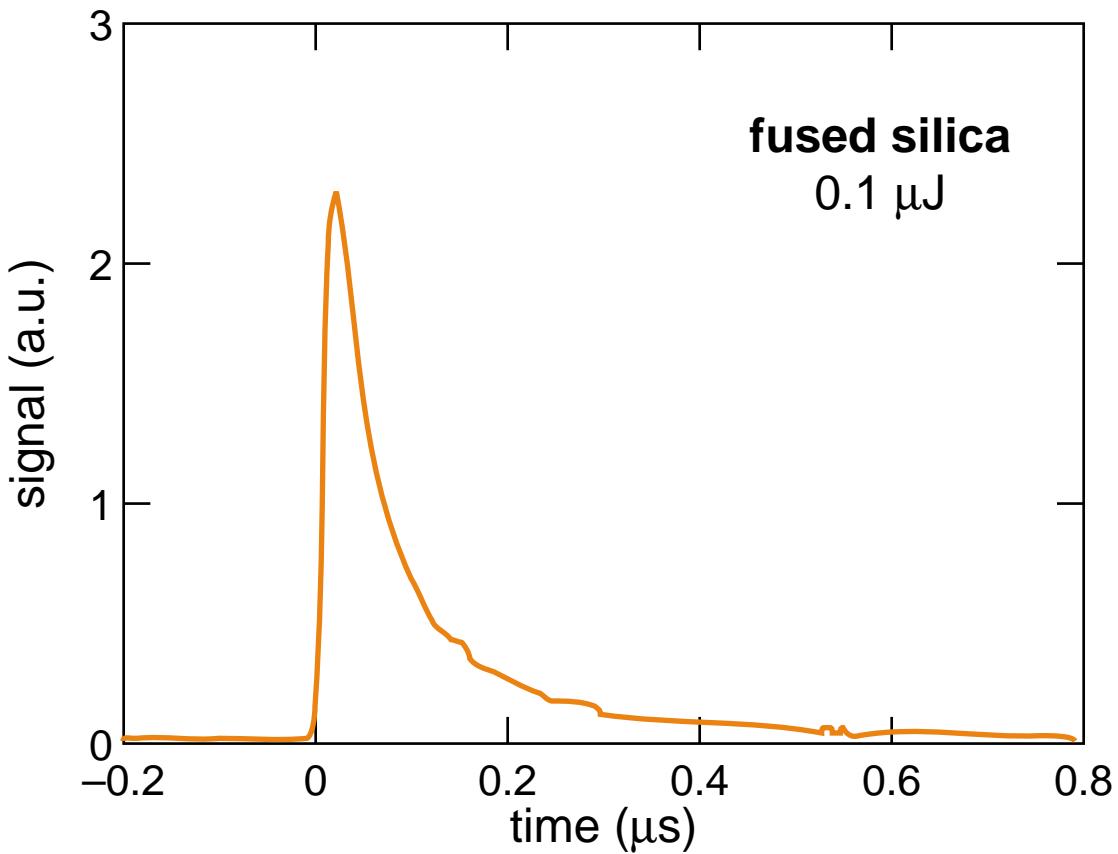


## *Role of focusing*

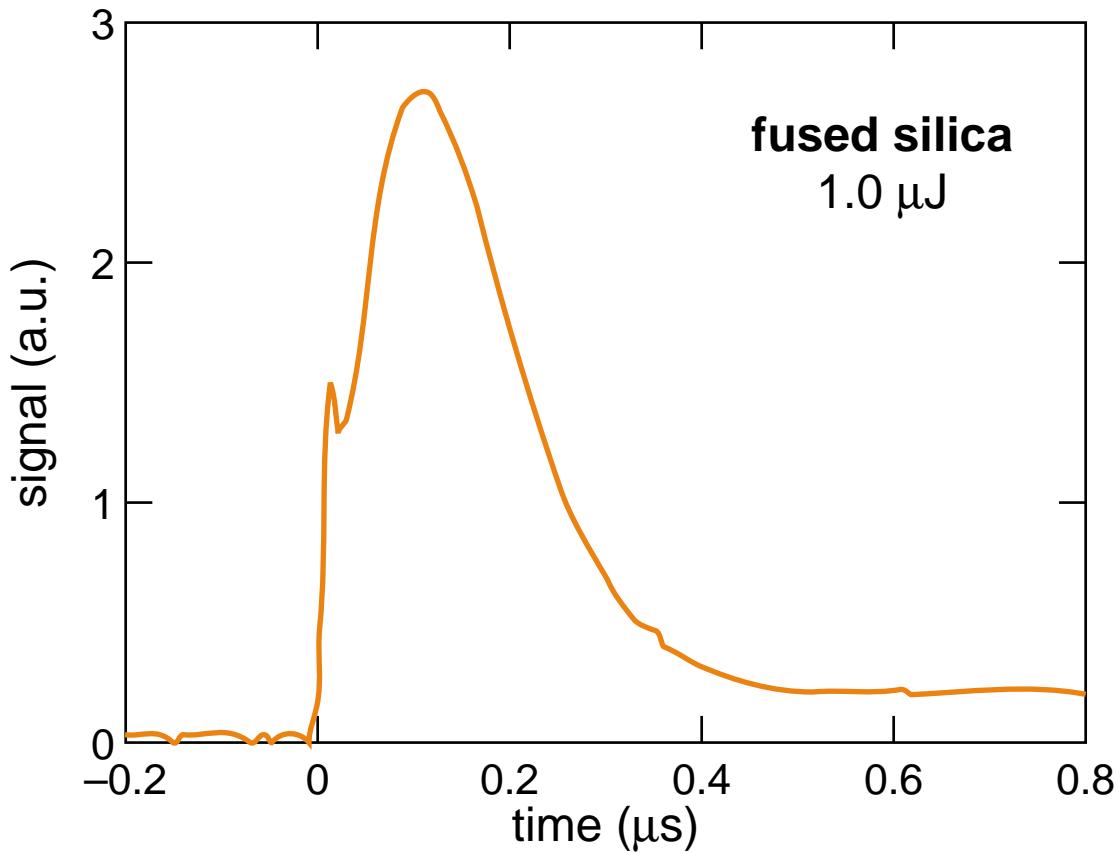
... damage scatters probe beam



## *Role of focusing*

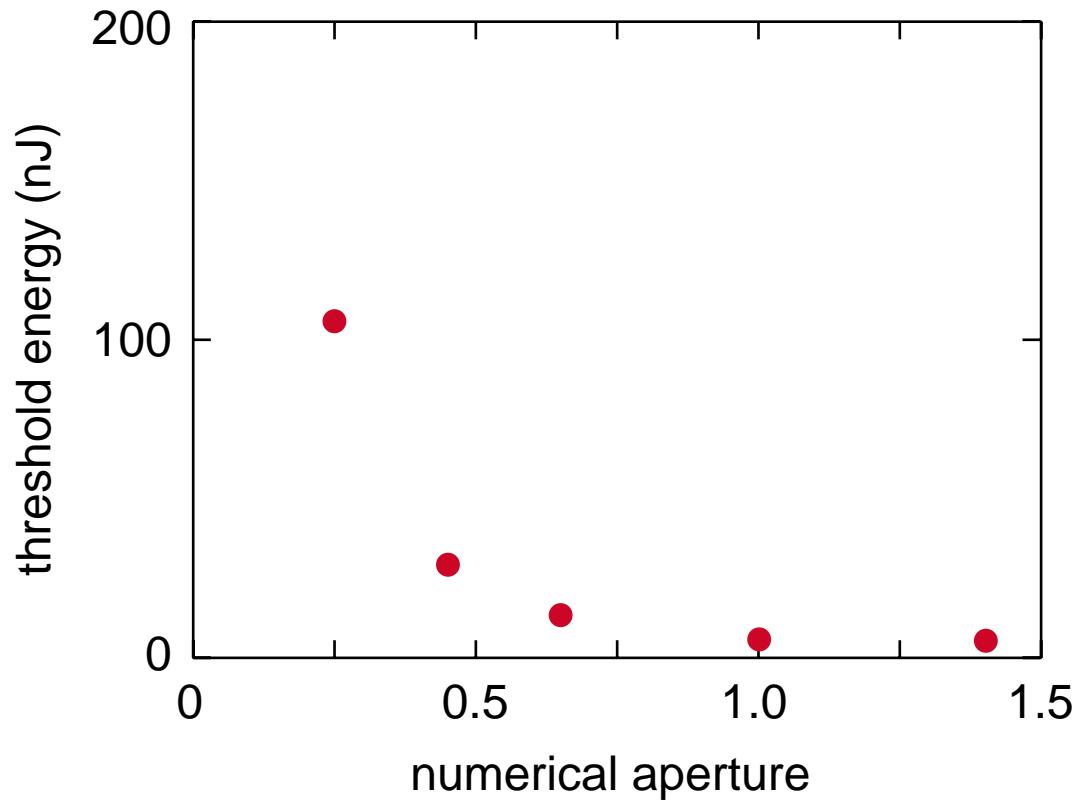


## *Role of focusing*

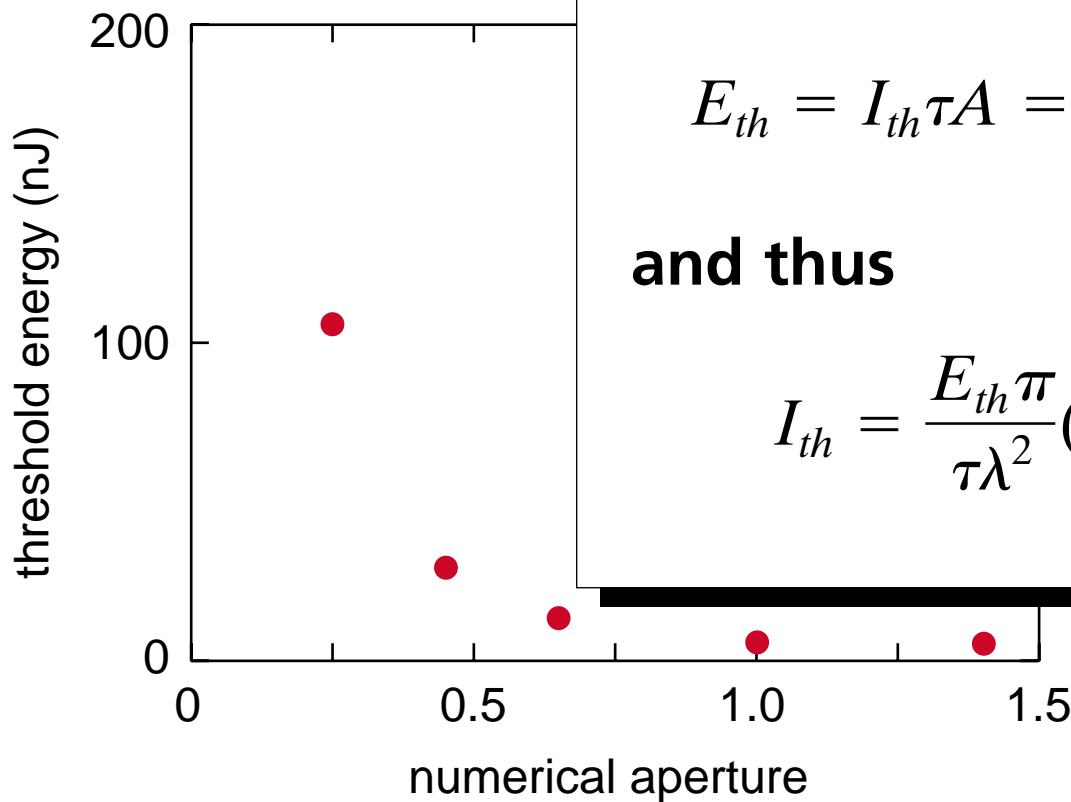


## *Role of focusing*

vary numerical aperture in Corning 0211



## *Role of focusing*



**spot size determined by numerical aperture:**

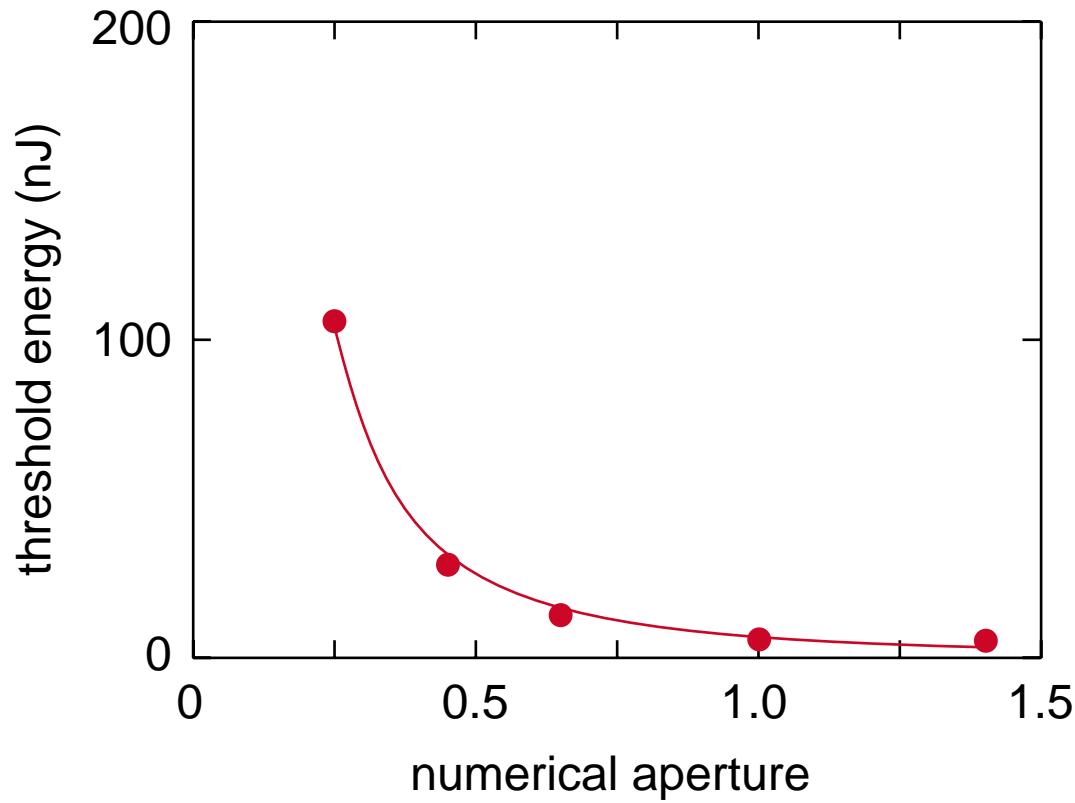
$$E_{th} = I_{th}\tau A = \frac{I_{th}\tau\lambda^2}{\pi(\text{NA})^2}$$

**and thus**

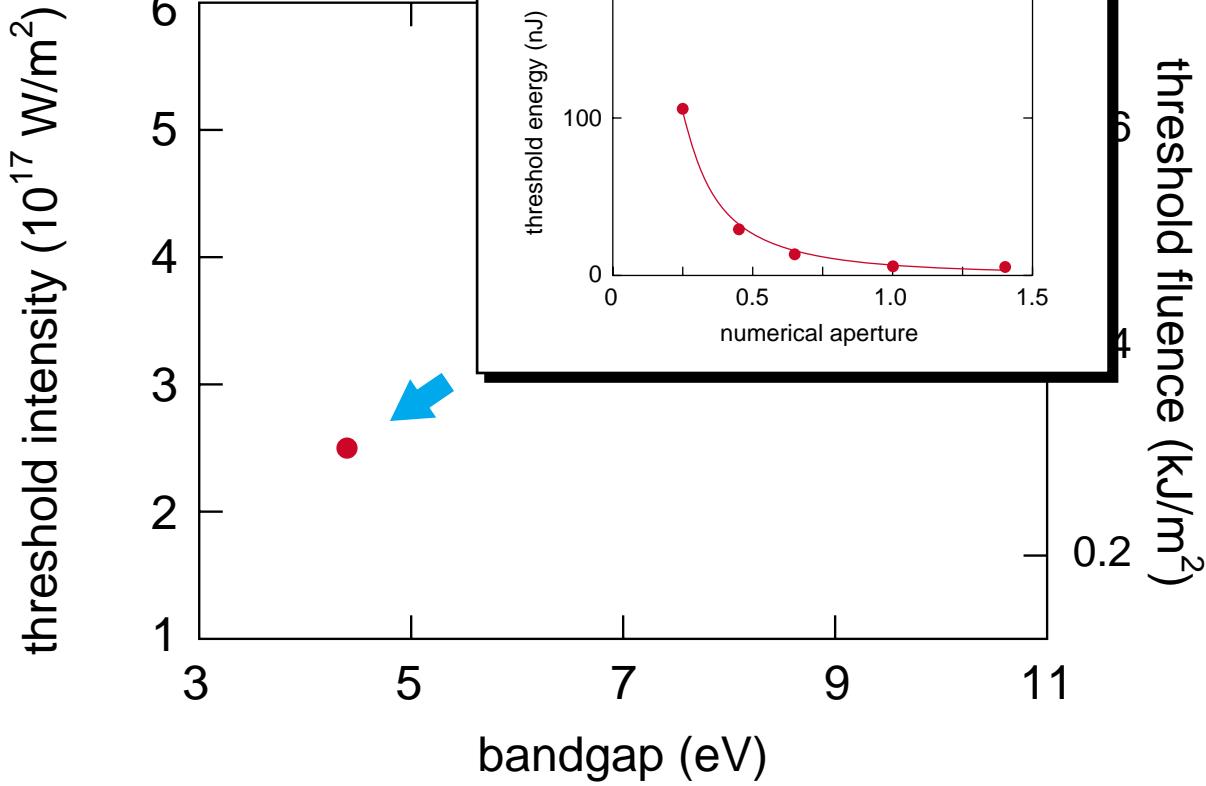
$$I_{th} = \frac{E_{th}\pi}{\tau\lambda^2}(\text{NA})^2$$

## *Role of focusing*

**fit gives threshold intensity:  $I_{th} = 2.5 \times 10^{17} \text{ W/m}^2$**

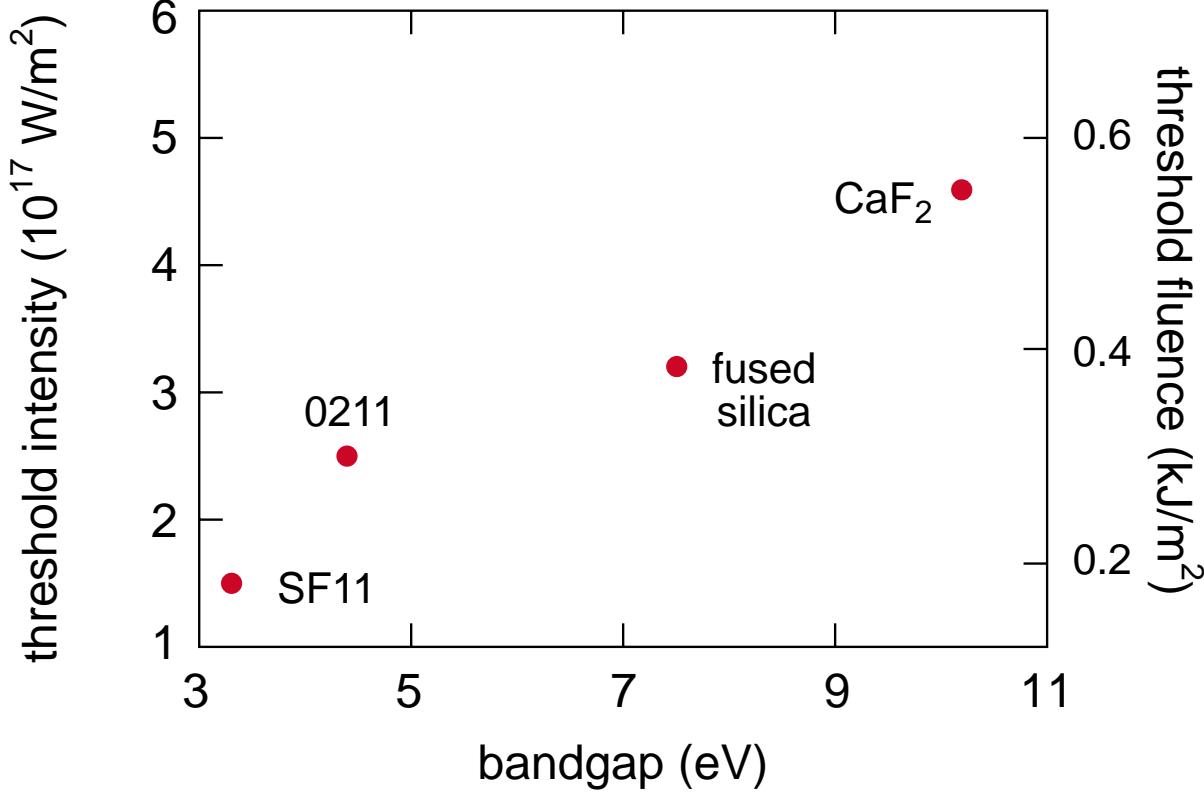


# *Role of focusing*



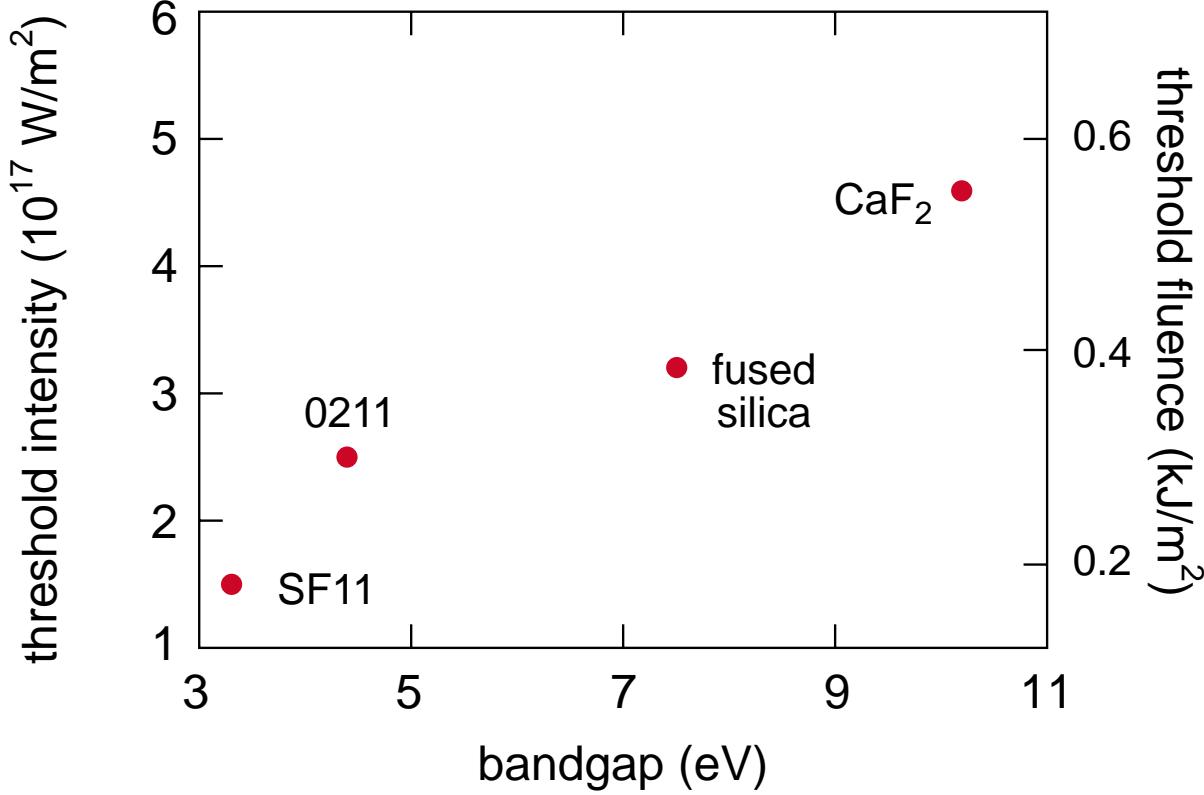
# *Role of focusing*

vary material...



## *Role of focusing*

**threshold varies with bandgap**



## *Role of focusing*

### Points to keep in mind:

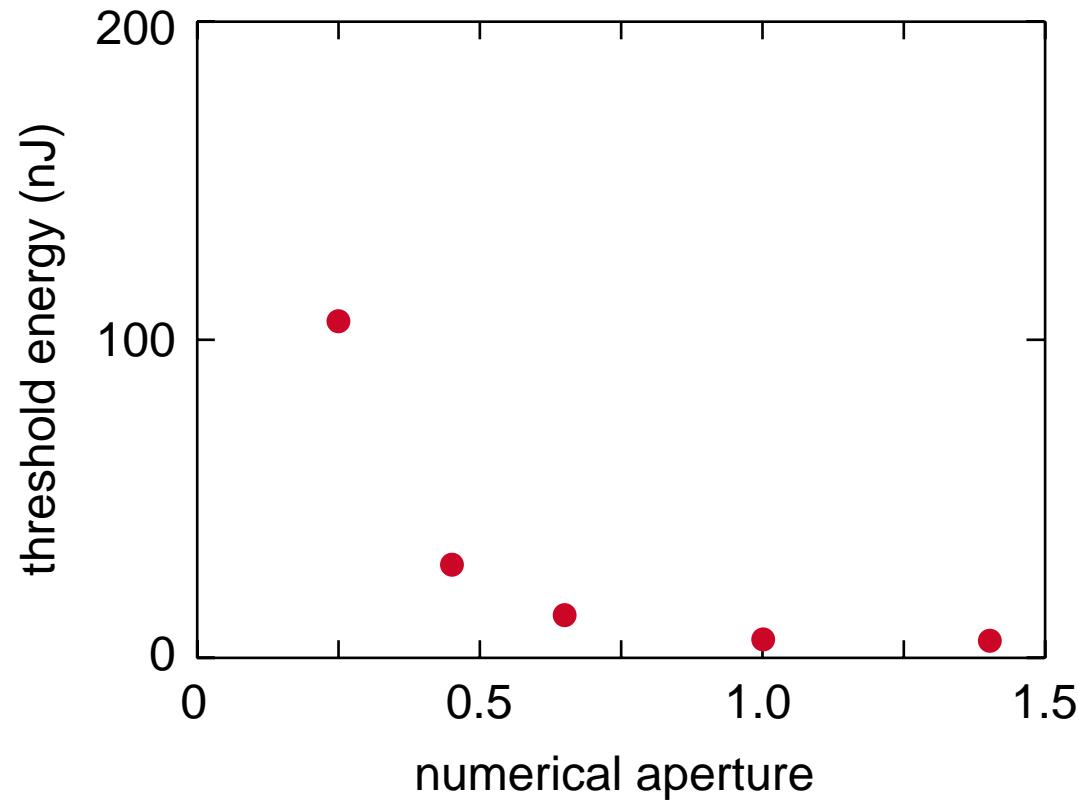
- ▶ threshold critically dependent on NA
- ▶ surprisingly little material dependence
- ▶ avalanche ionization important

# *Outline*

- ▶ Processing with fs pulses
- ▶ Role of focusing
- ▶ Low-energy processing

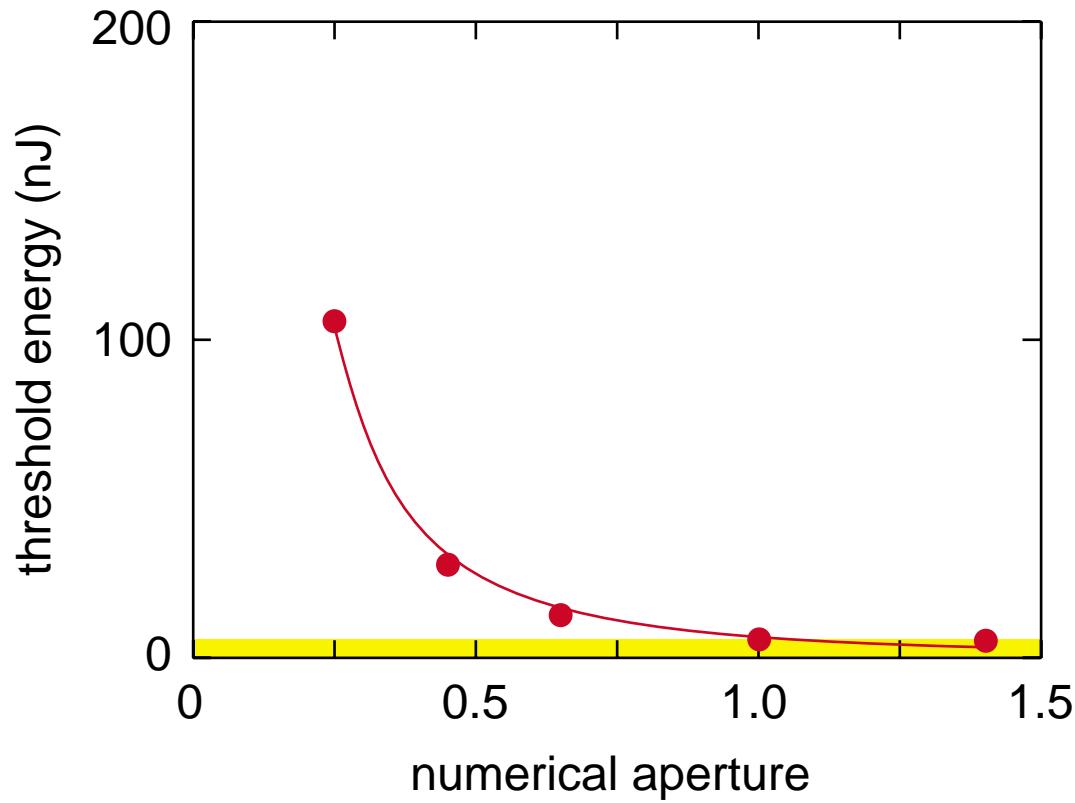
## *Low-energy processing*

**threshold decreases with increasing numerical aperture**



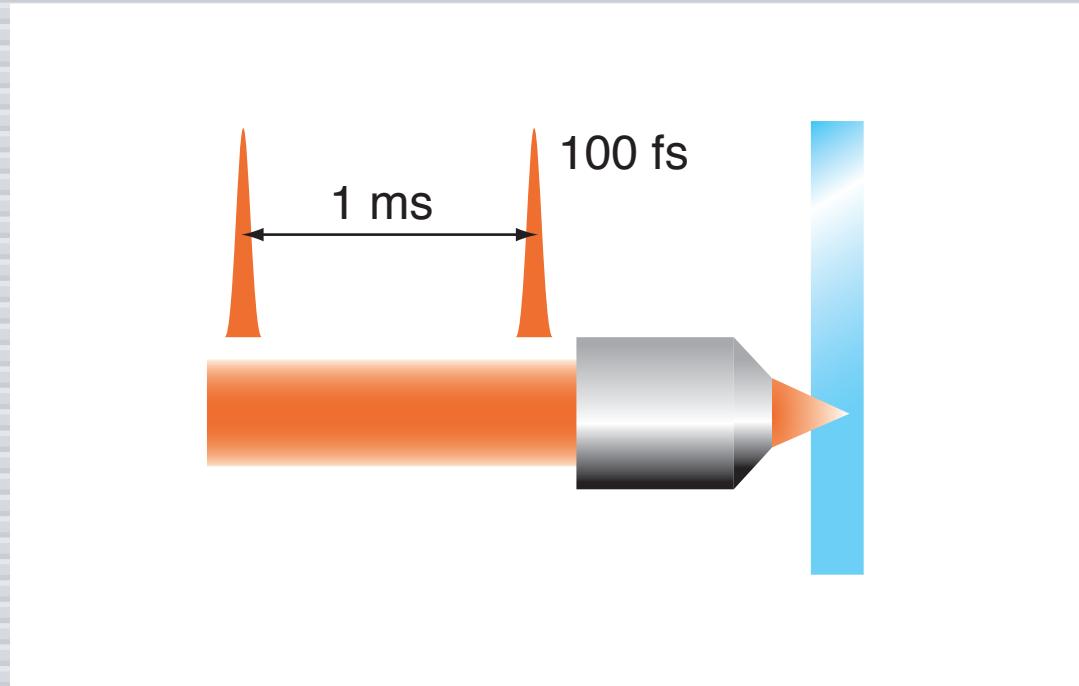
## *Low-energy processing*

**less than 10 nJ at high numerical aperture!**



# *Low-energy processing*

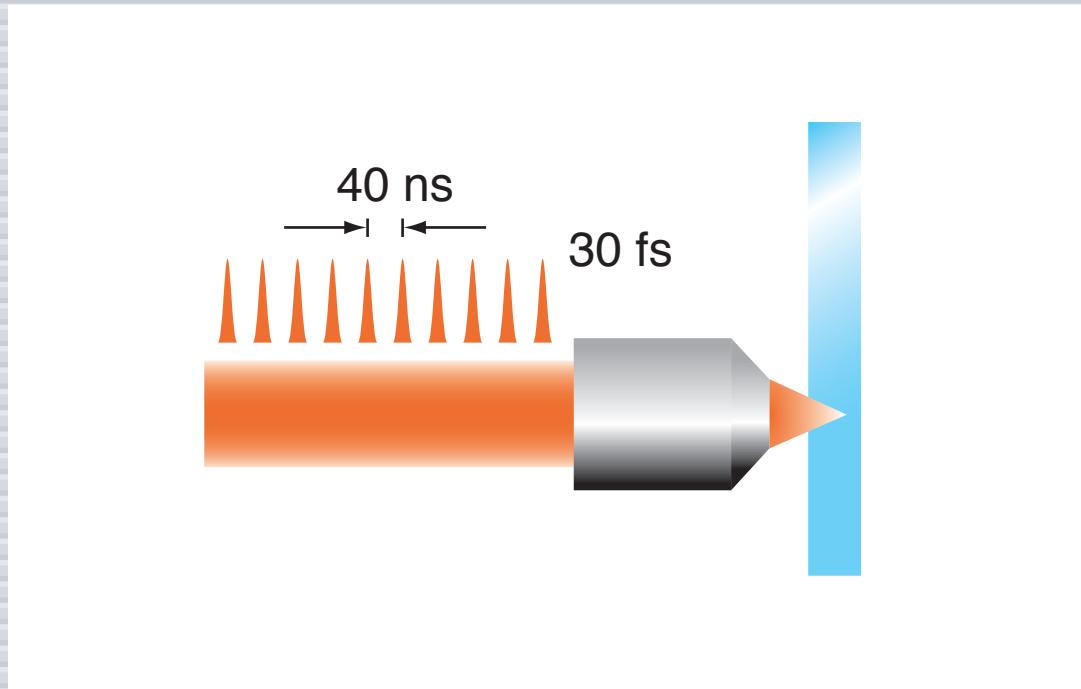
**amplified laser: 1 kHz, 1 mJ**



**heat diffusion time:**  $\tau_{diff} \approx 1 \mu\text{s}$

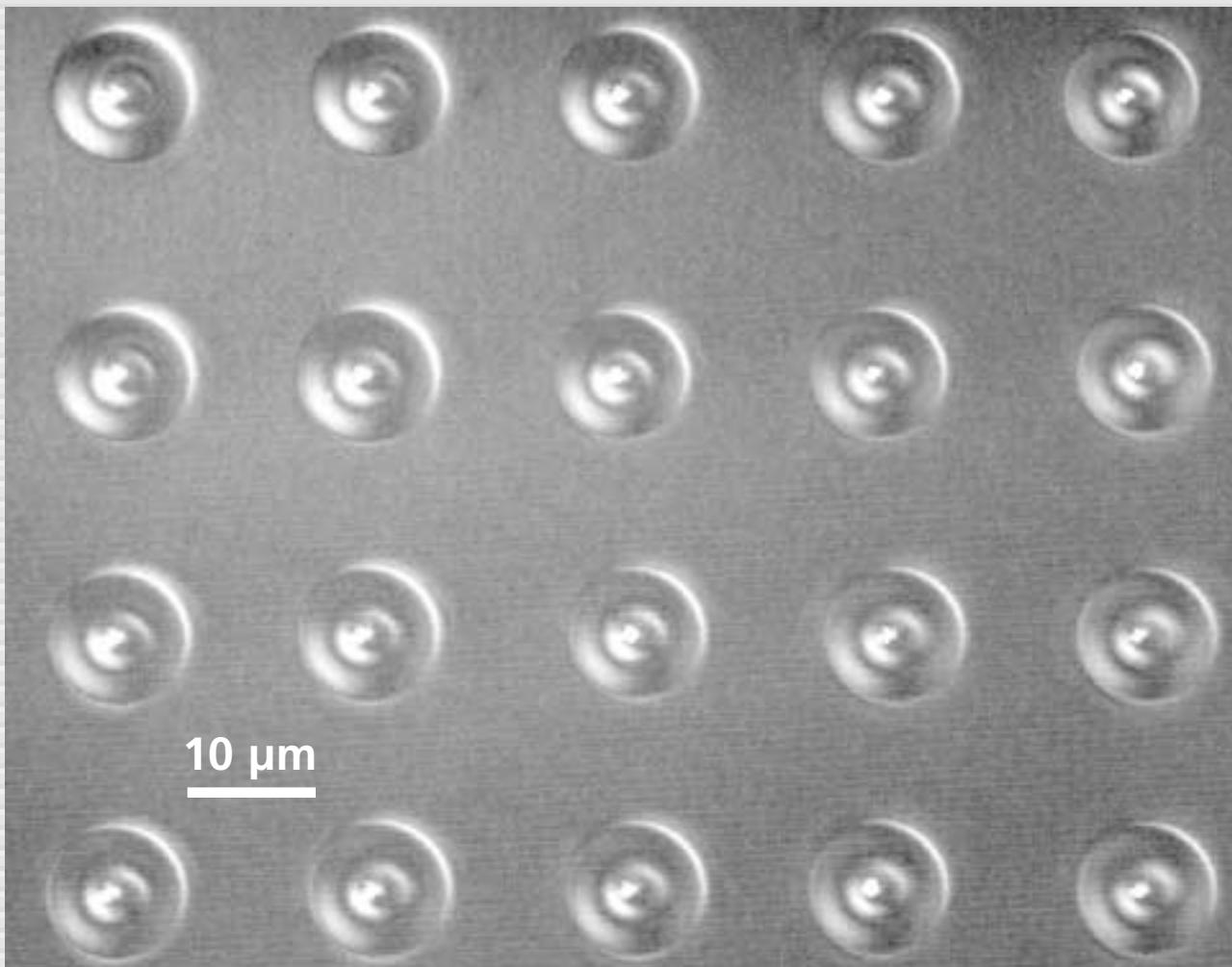
## *Low-energy processing*

**long cavity oscillator: 25 MHz, 25 nJ**



**heat diffusion time:**  $\tau_{diff} \approx 1 \mu\text{s}$

## *Low-energy processing*

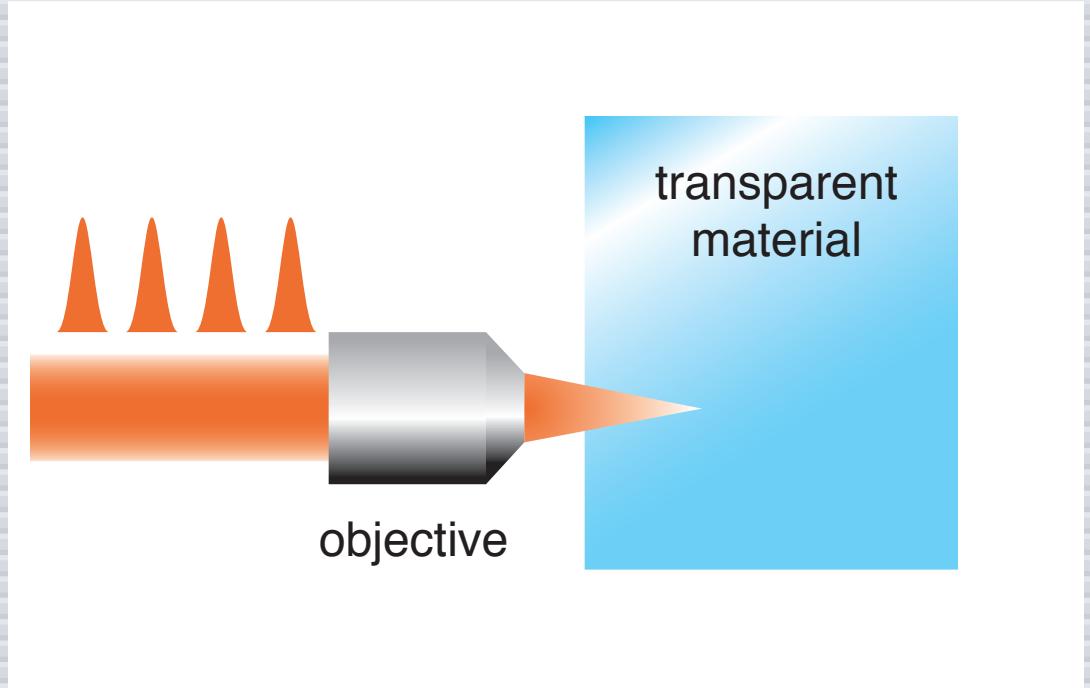


## *Low-energy processing*

**high repetition-rate micromachining:**

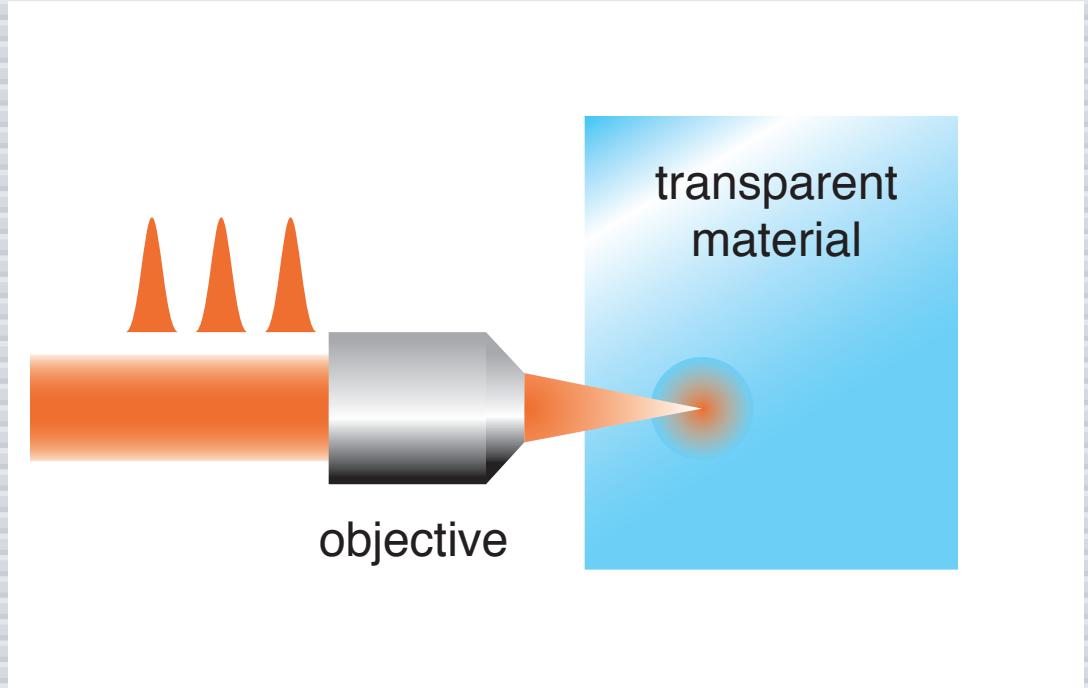
- ▶ structural changes exceed focal volume
- ▶ spherical structures
- ▶ density change caused by melting

## *Low-energy processing*



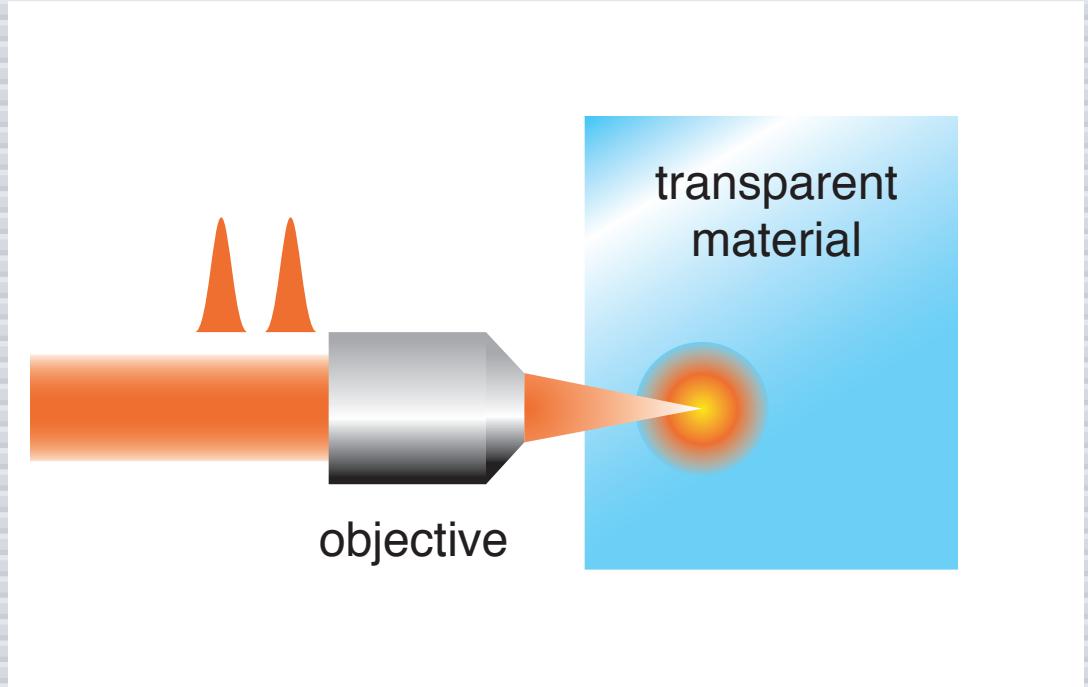
**cumulative energy deposition**

## *Low-energy processing*



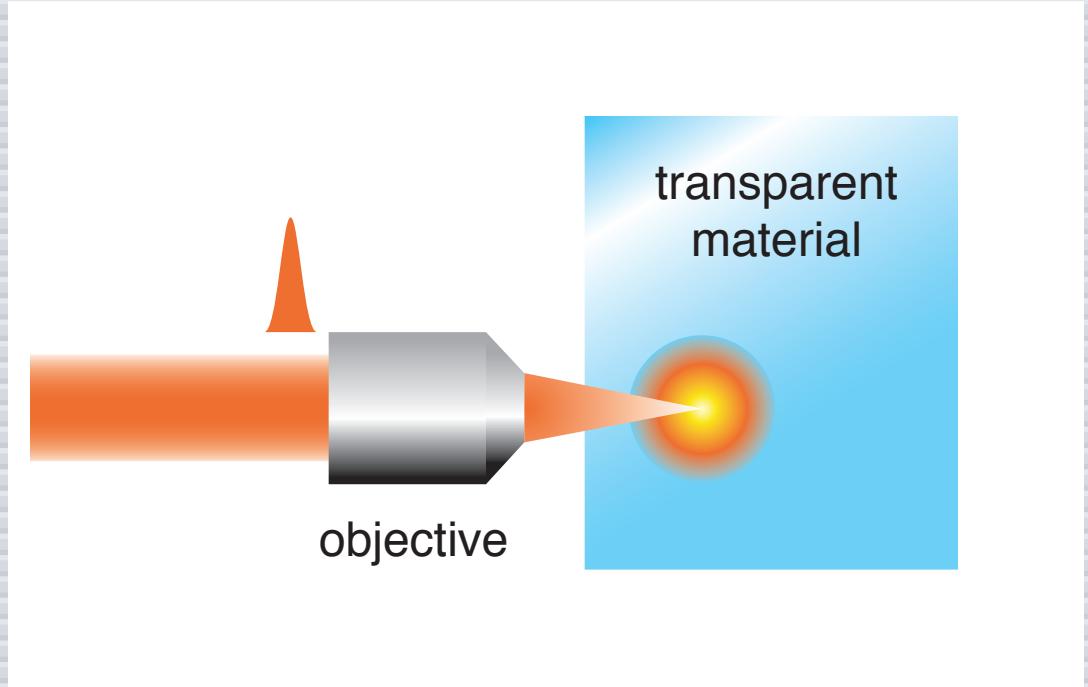
**cumulative energy deposition**

## *Low-energy processing*



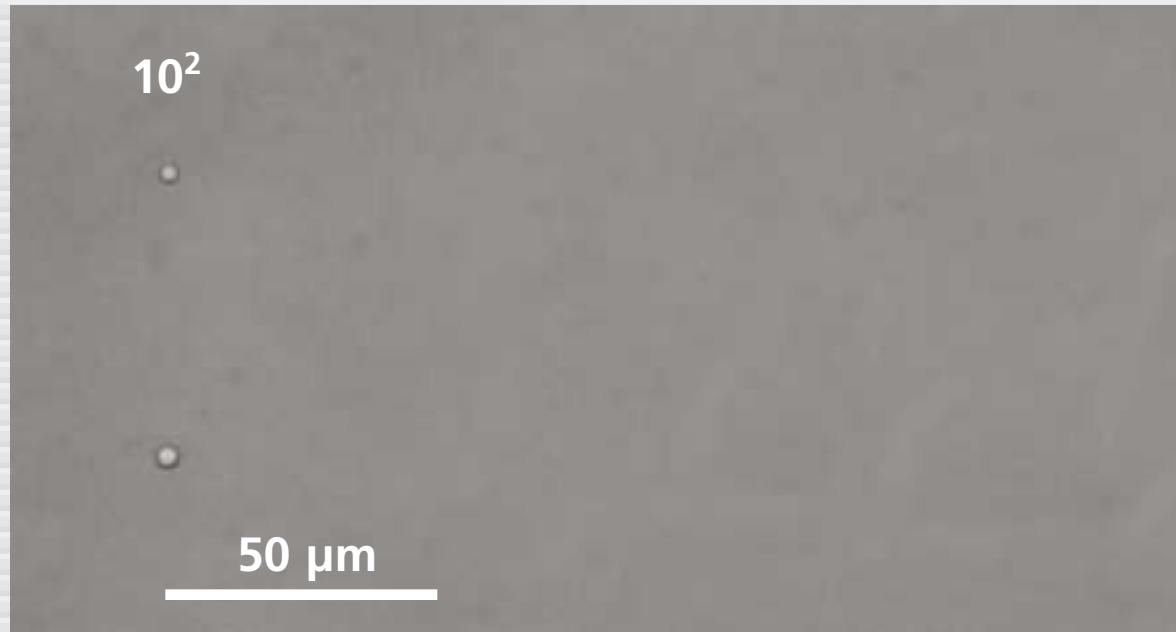
**cumulative energy deposition**

## *Low-energy processing*

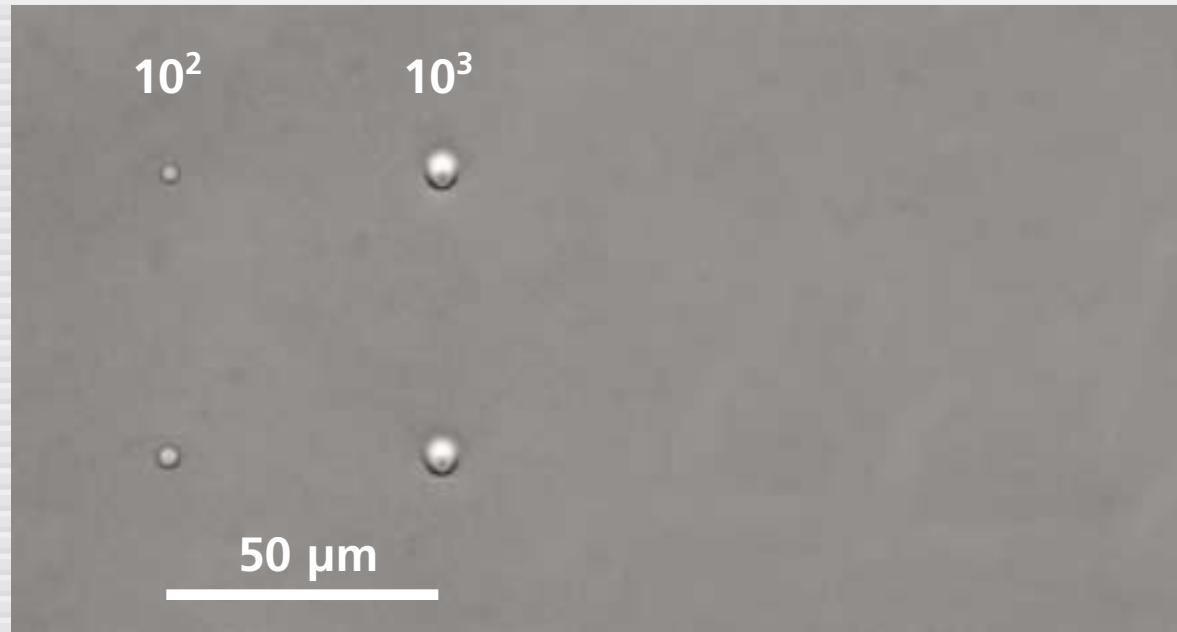


**cumulative energy deposition**

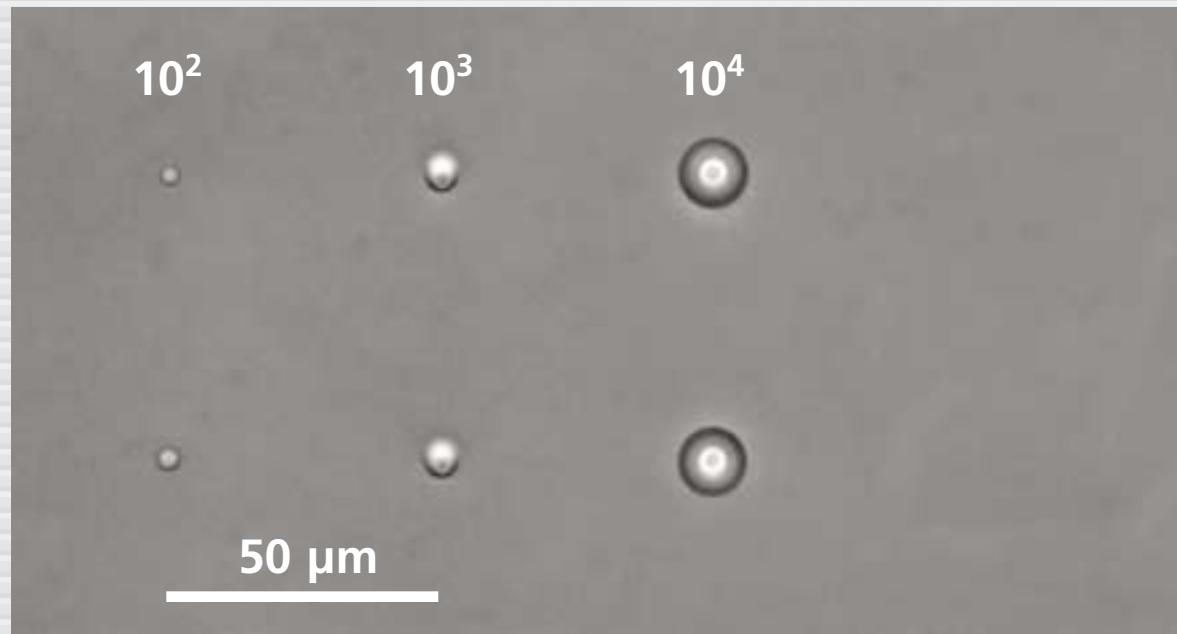
## *Low-energy processing*



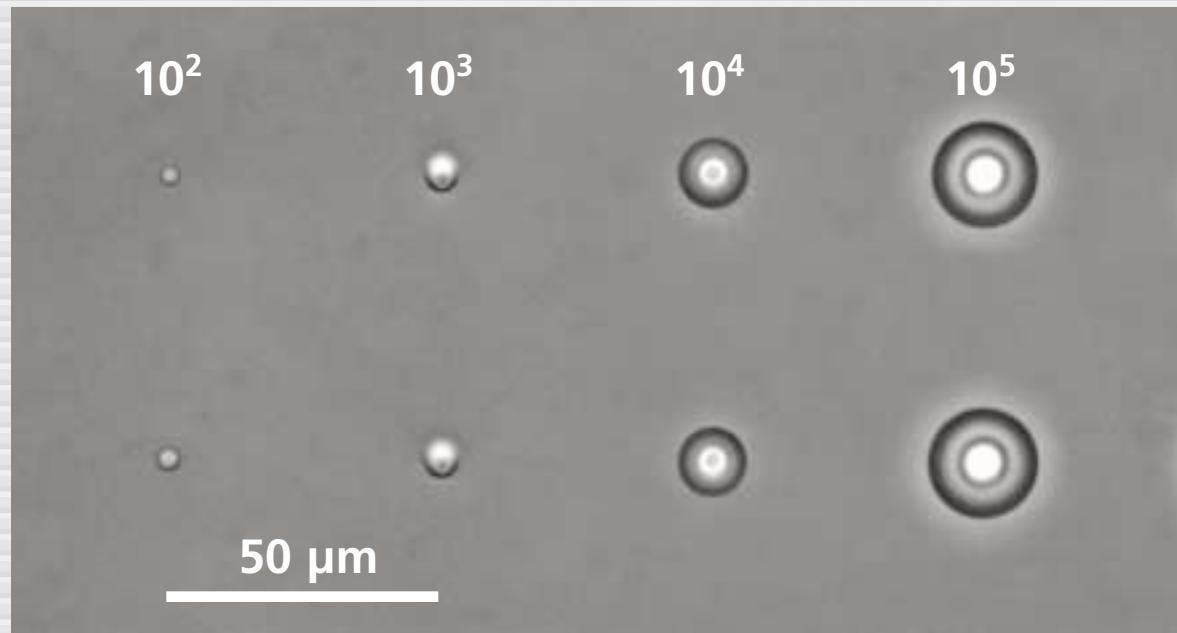
## *Low-energy processing*



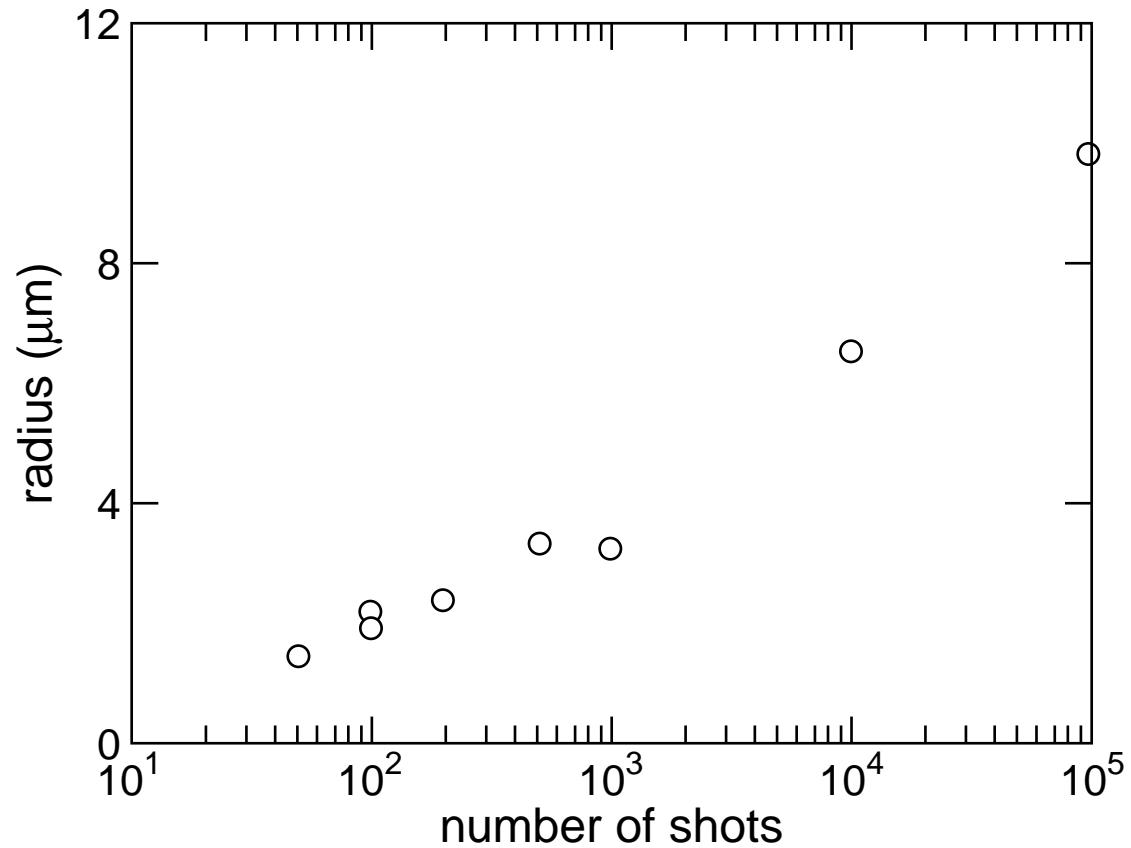
## *Low-energy processing*



## *Low-energy processing*



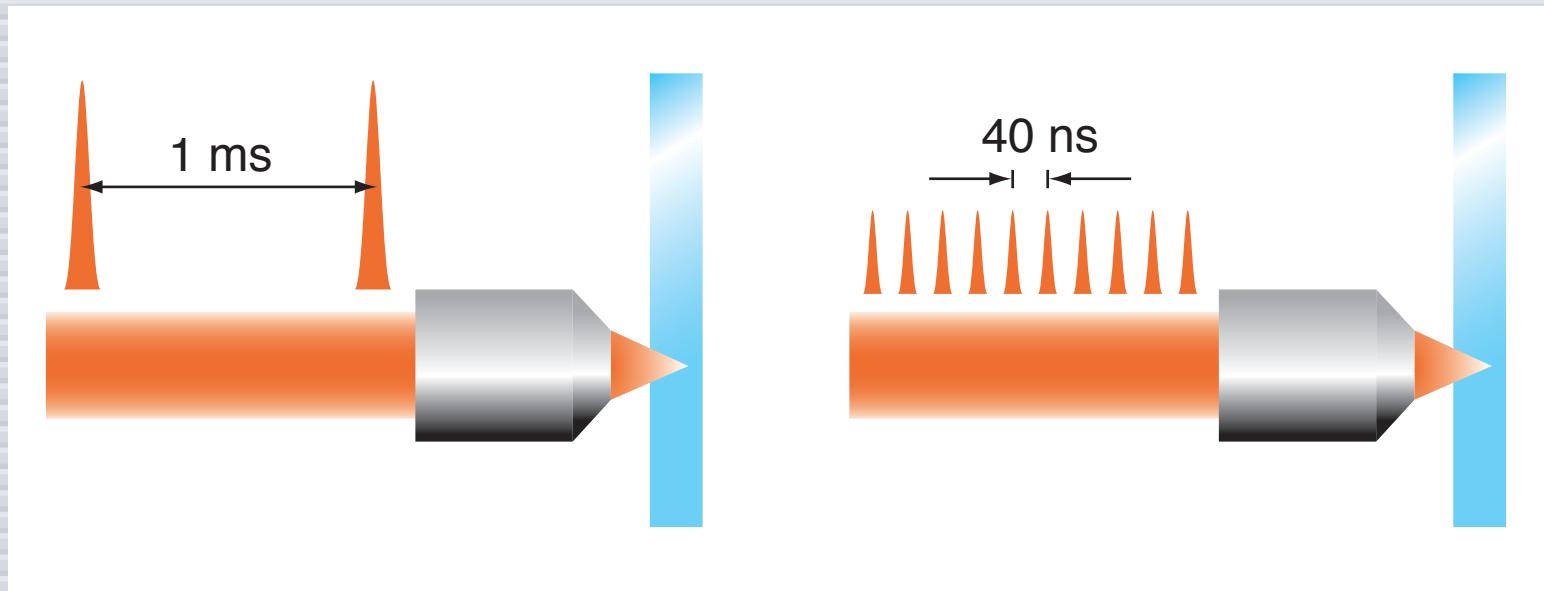
## *Low-energy processing*



# *Low-energy processing*

**amplified laser**

**oscillator**

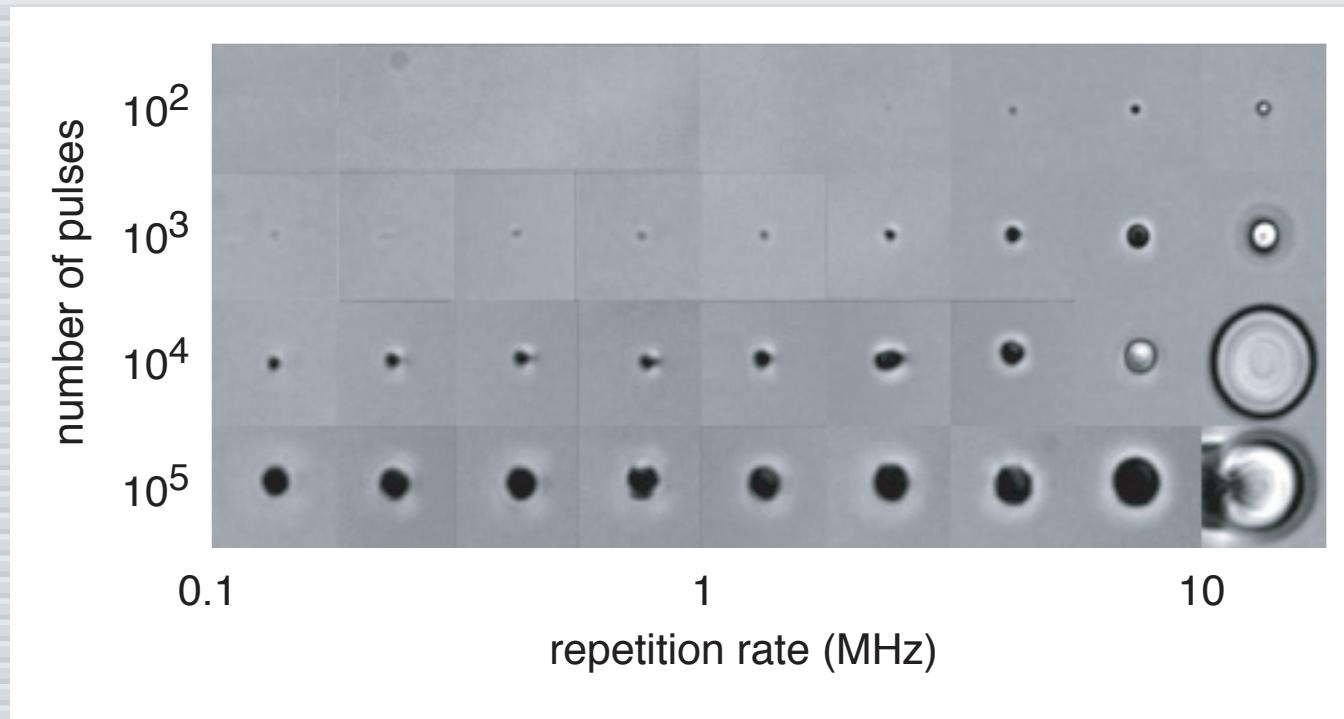


**repetitive**

**cumulative**

# *Low-energy processing*

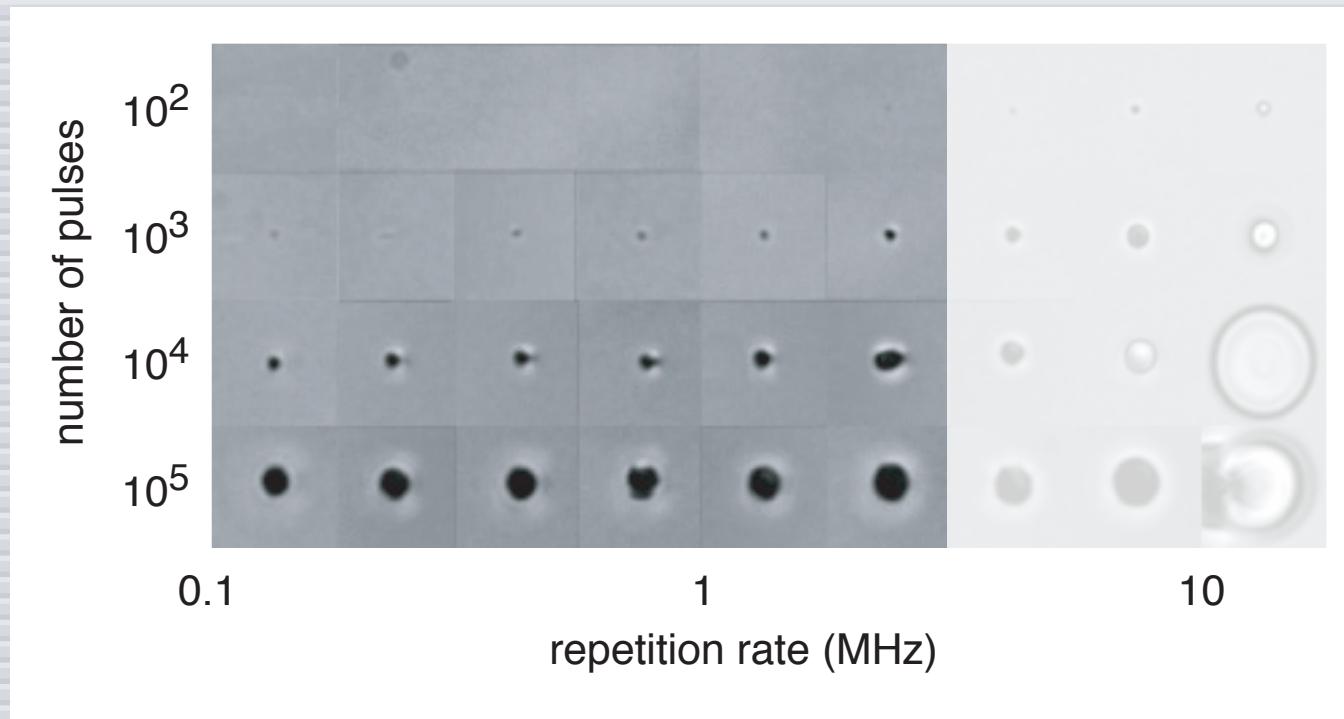
## repetition-rate dependence



**As<sub>2</sub>S<sub>3</sub>, 100 fs, 7 nJ**

# *Low-energy processing*

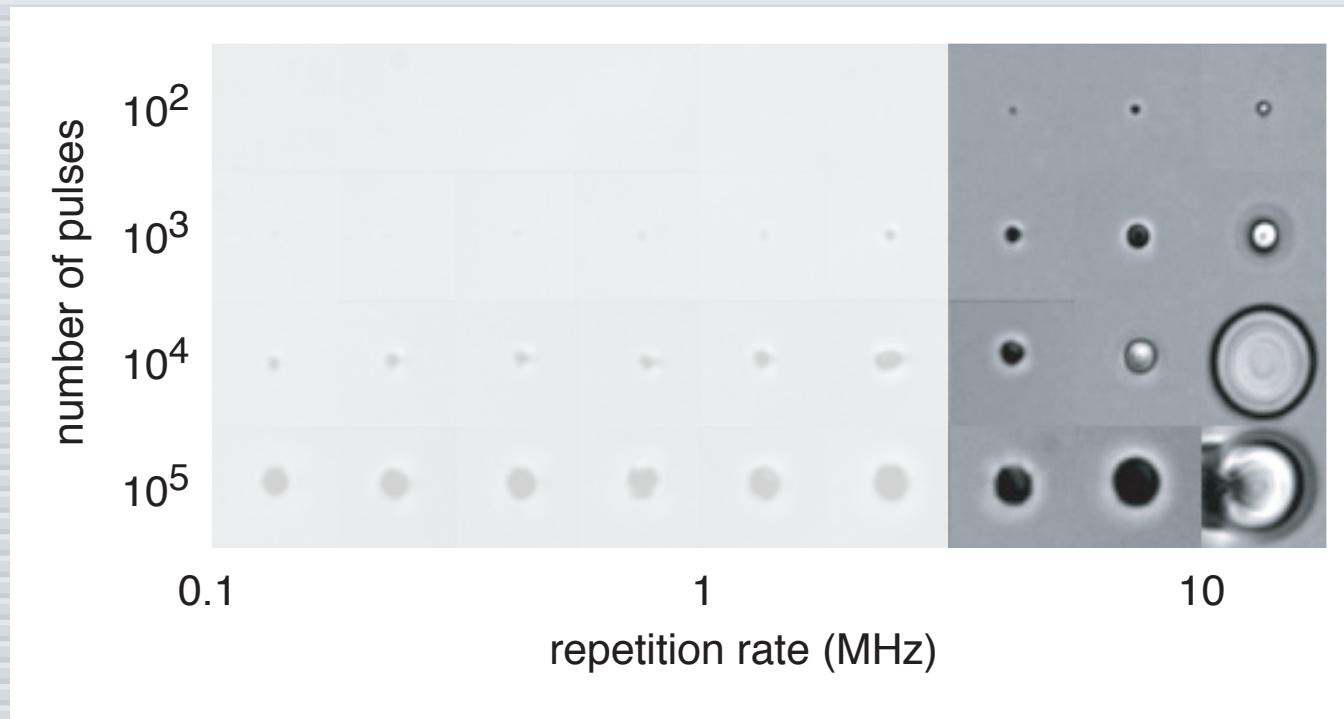
## repetition-rate dependence



**As<sub>2</sub>S<sub>3</sub>, 100 fs, 7 nJ**

# *Low-energy processing*

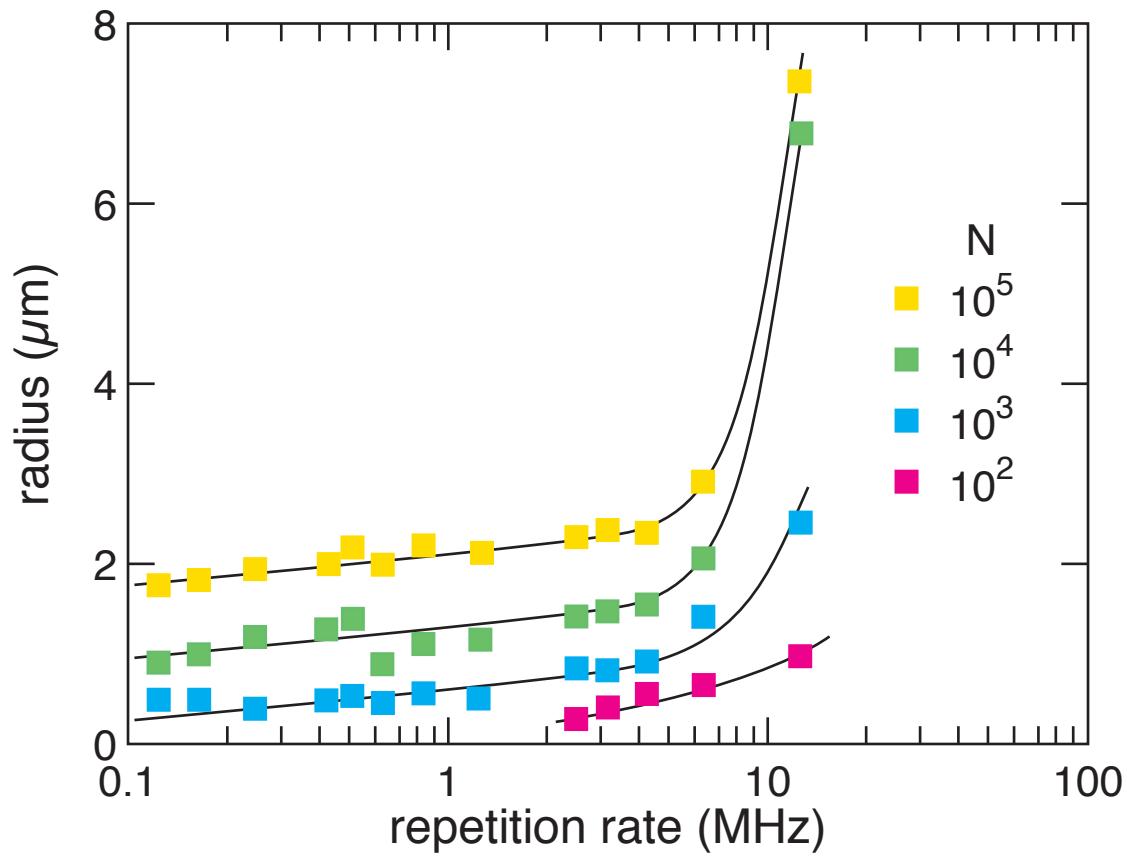
## repetition-rate dependence



**As<sub>2</sub>S<sub>3</sub>, 100 fs, 7 nJ**

# *Low-energy processing*

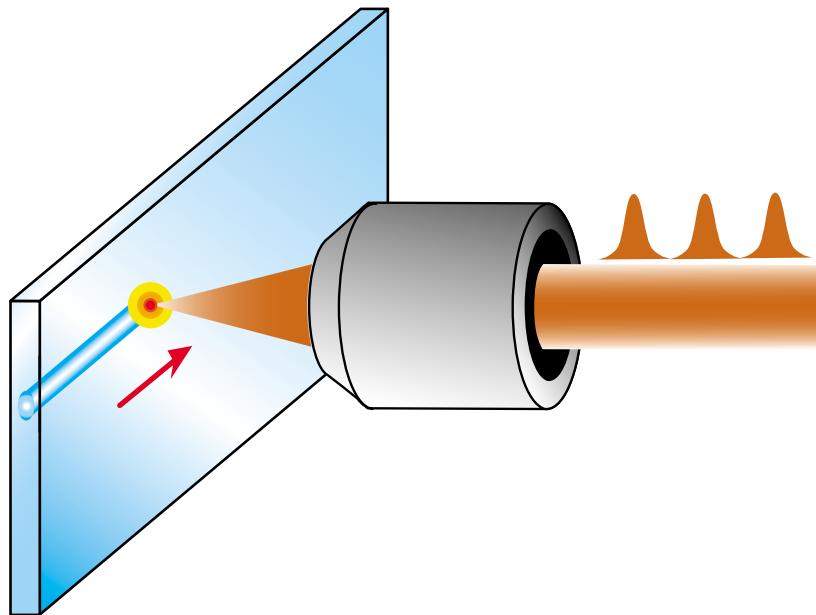
## repetition-rate dependence



$\text{As}_2\text{S}_3$ , 100 fs, 7 nJ

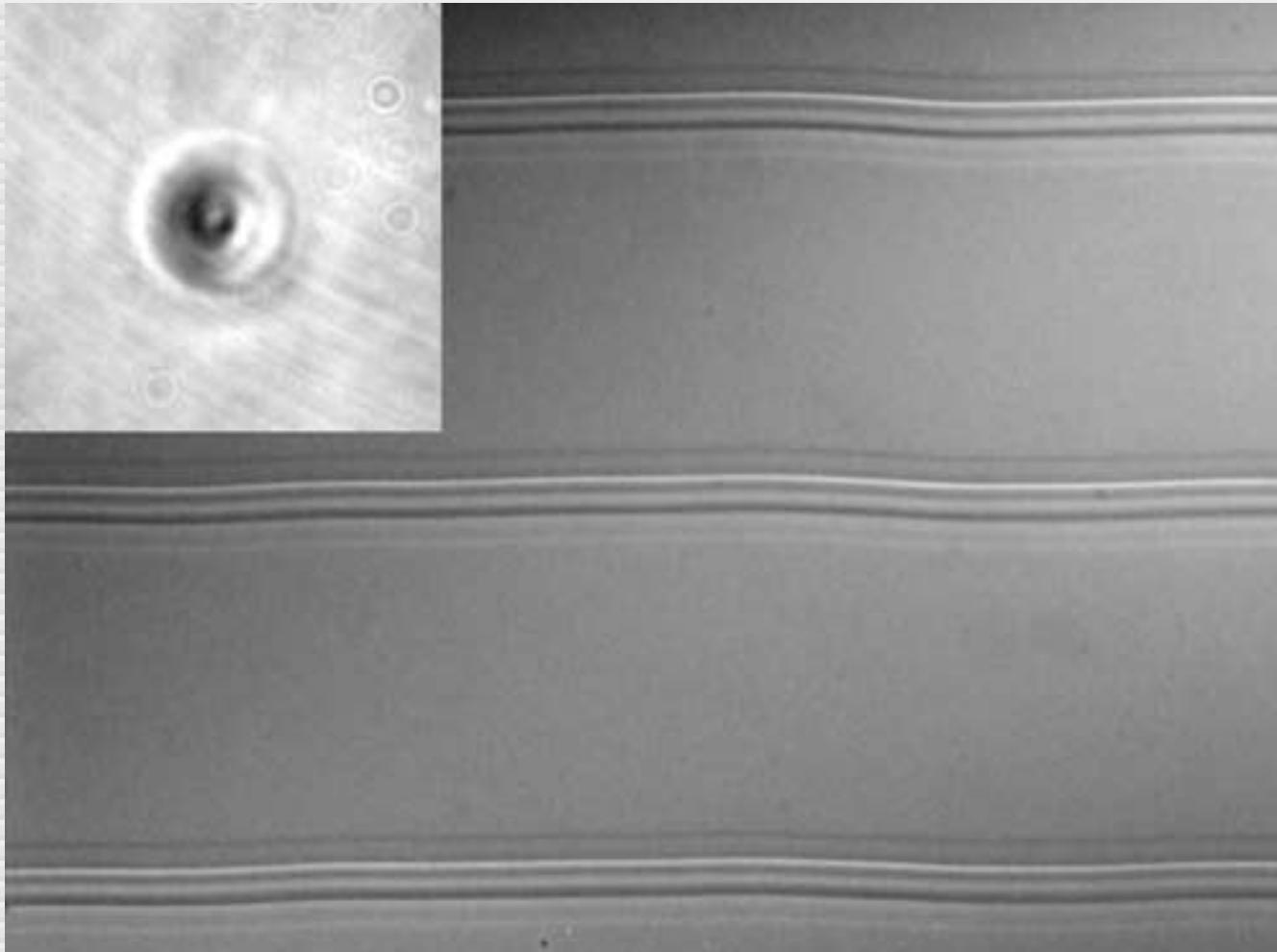
*Low-energy processing*

## waveguide machining



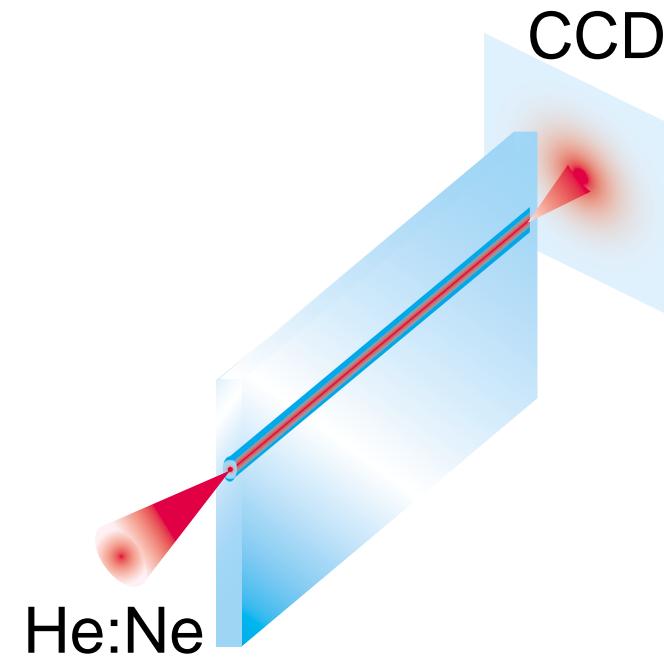
*Low-energy processing*

## waveguide machining



*Low-energy processing*

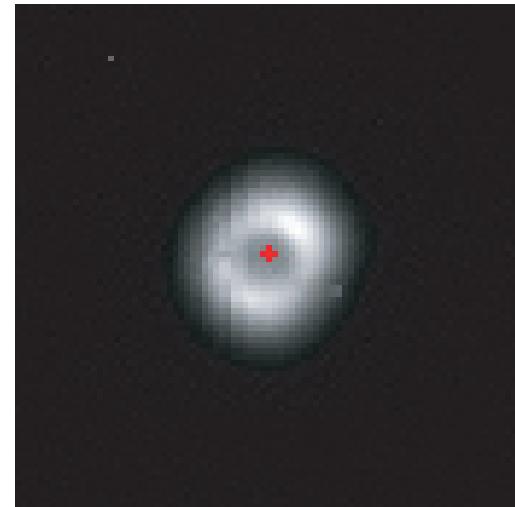
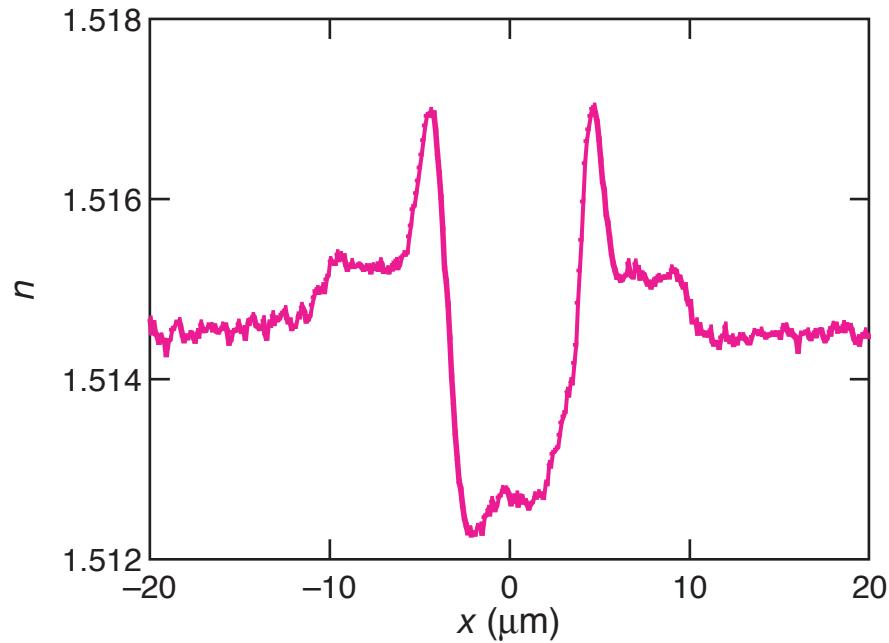
## waveguide mode analysis



# *Low-energy processing*

**refractive index profiles and near field mode at 633 nm**

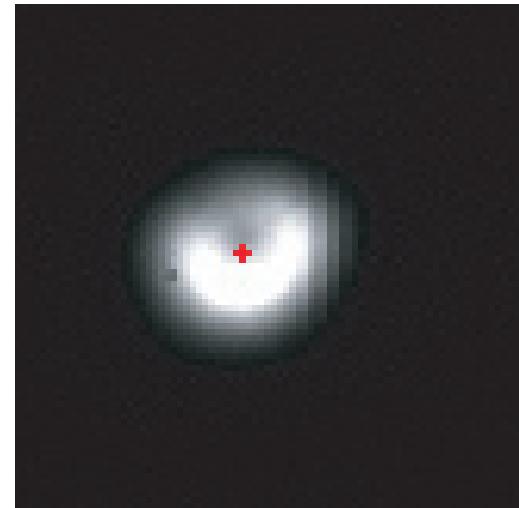
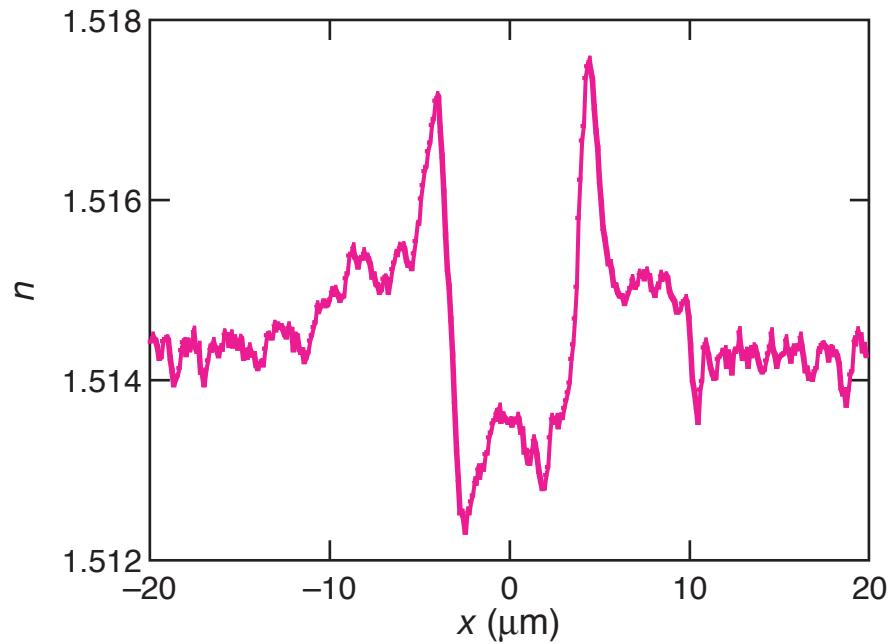
**5 mm/s**



## *Low-energy processing*

**refractive index profiles and near field mode at 633 nm**

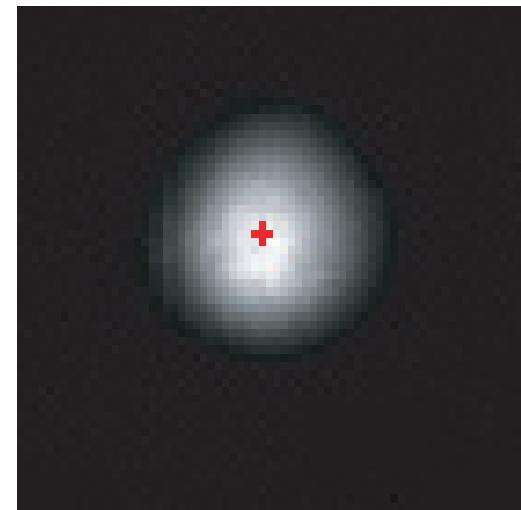
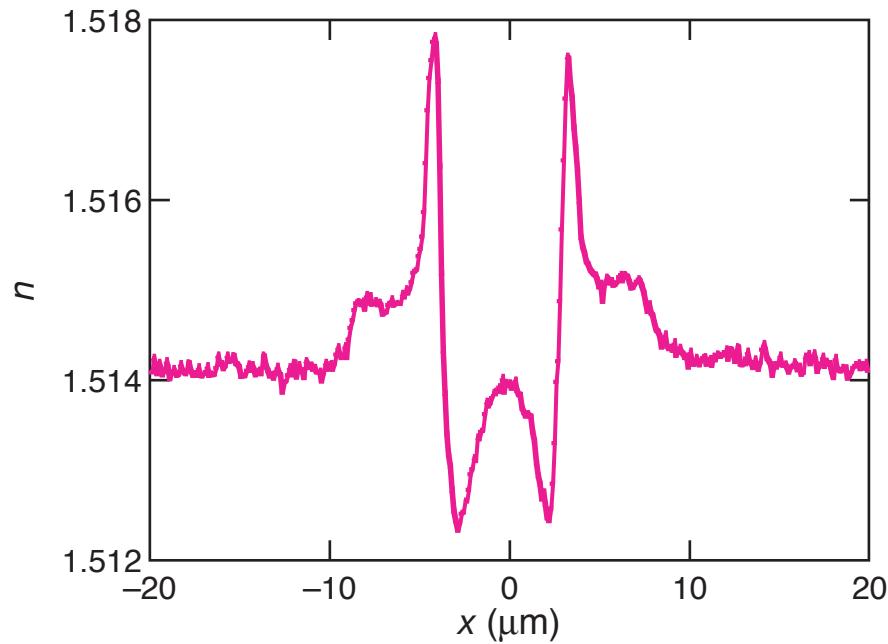
**10 mm/s**



# *Low-energy processing*

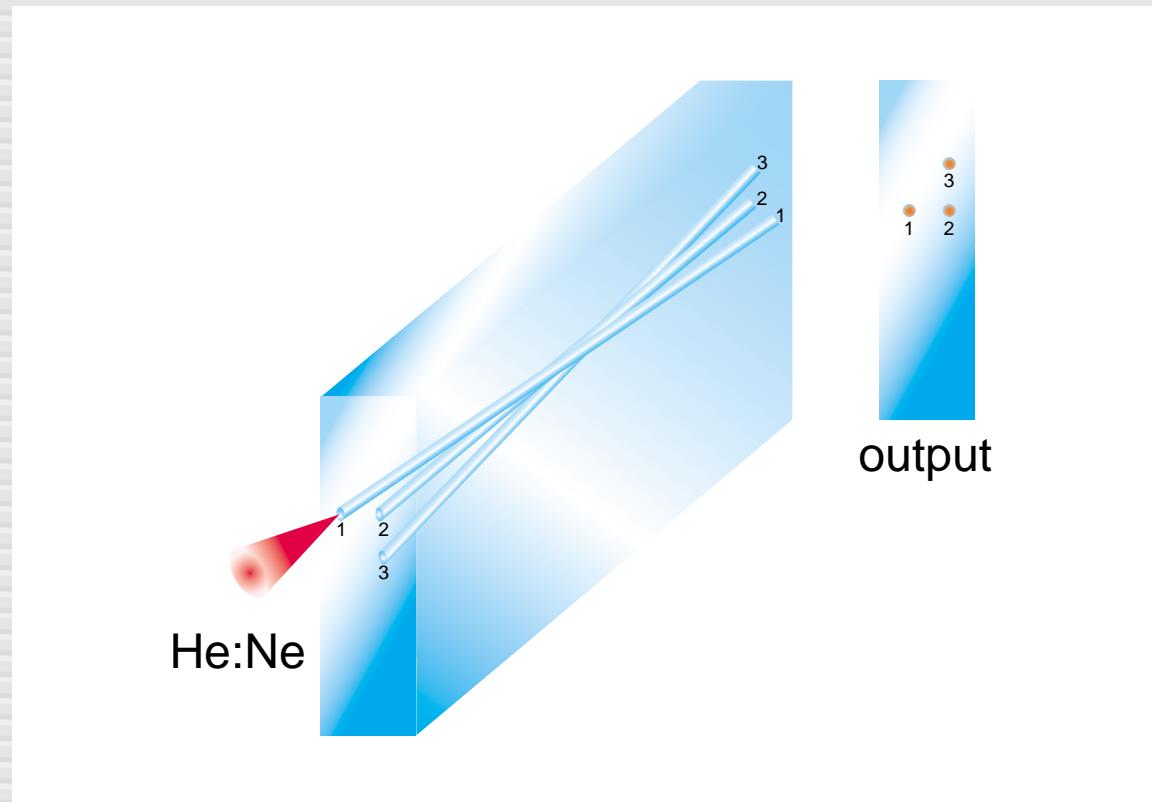
**refractive index profiles and near field mode at 633 nm**

**20 mm/s**



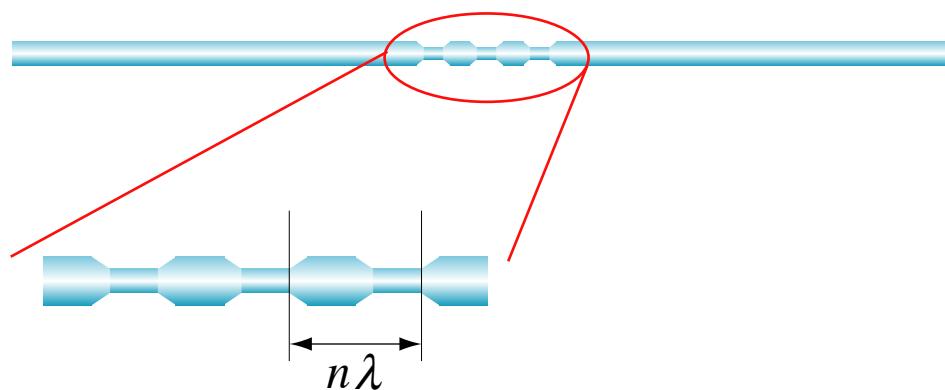
# *Low-energy processing*

## 3D wave splitter



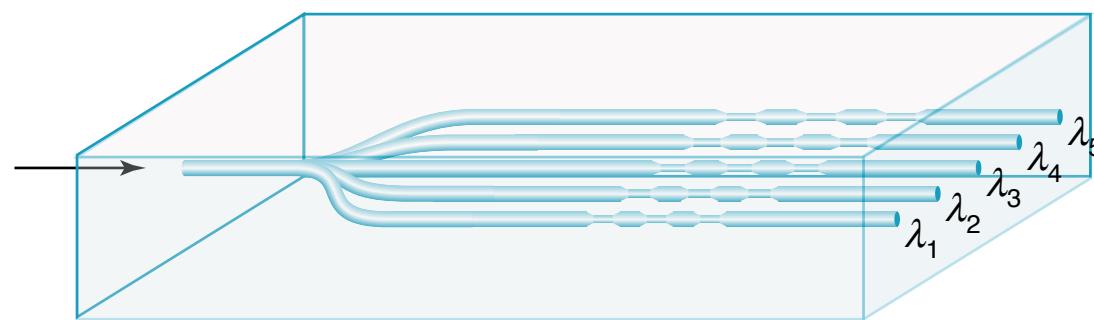
# *Low-energy processing*

## Bragg grating



# *Low-energy processing*

## Bragg grating



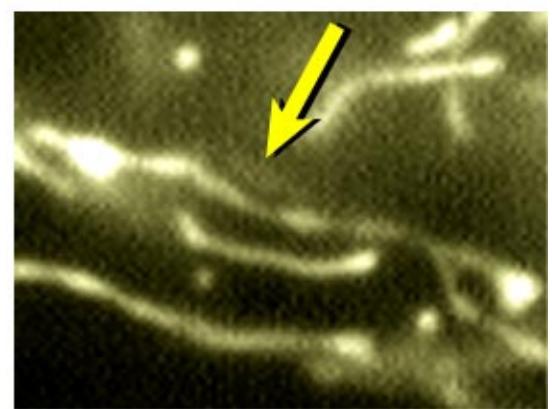
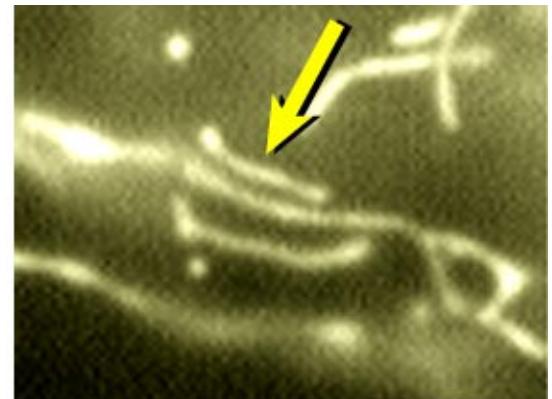
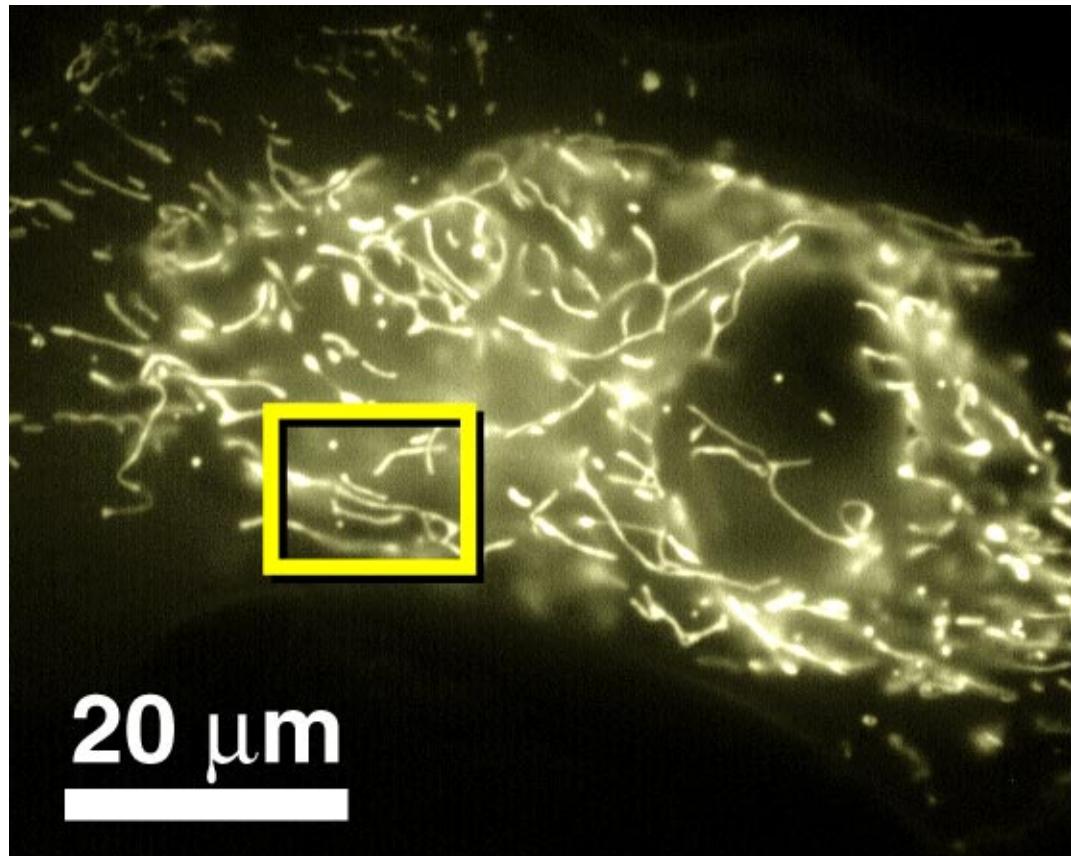
*Low-energy processing*

## **monolithic amplifier**



laser active glass

## *Low-energy processing*



## *Low-energy processing*

- ▶ **standard biochemical tools: species selective**
- ▶ **fs laser nanosurgery: site specific**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*



Juergen Berger & Ralph Sommer  
Max-Planck Institute for Developmental Biology

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ simple model organism

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ simple model organism
- ▶ similarities to higher organism

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **simple model organism**
- ▶ **similarities to higher organism**
- ▶ **genome fully sequenced**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **simple model organism**
- ▶ **similarities to higher organism**
- ▶ **genome fully sequenced**
- ▶ **easy to handle**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **80 µm x 1 mm**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **80 µm x 1 mm**
- ▶ **about 1300 cells**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **80 µm x 1 mm**
- ▶ **about 1300 cells**
- ▶ **302 neurons**

# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **80 µm x 1 mm**
- ▶ **about 1300 cells**
- ▶ **302 neurons**
- ▶ **invariant wiring diagram**

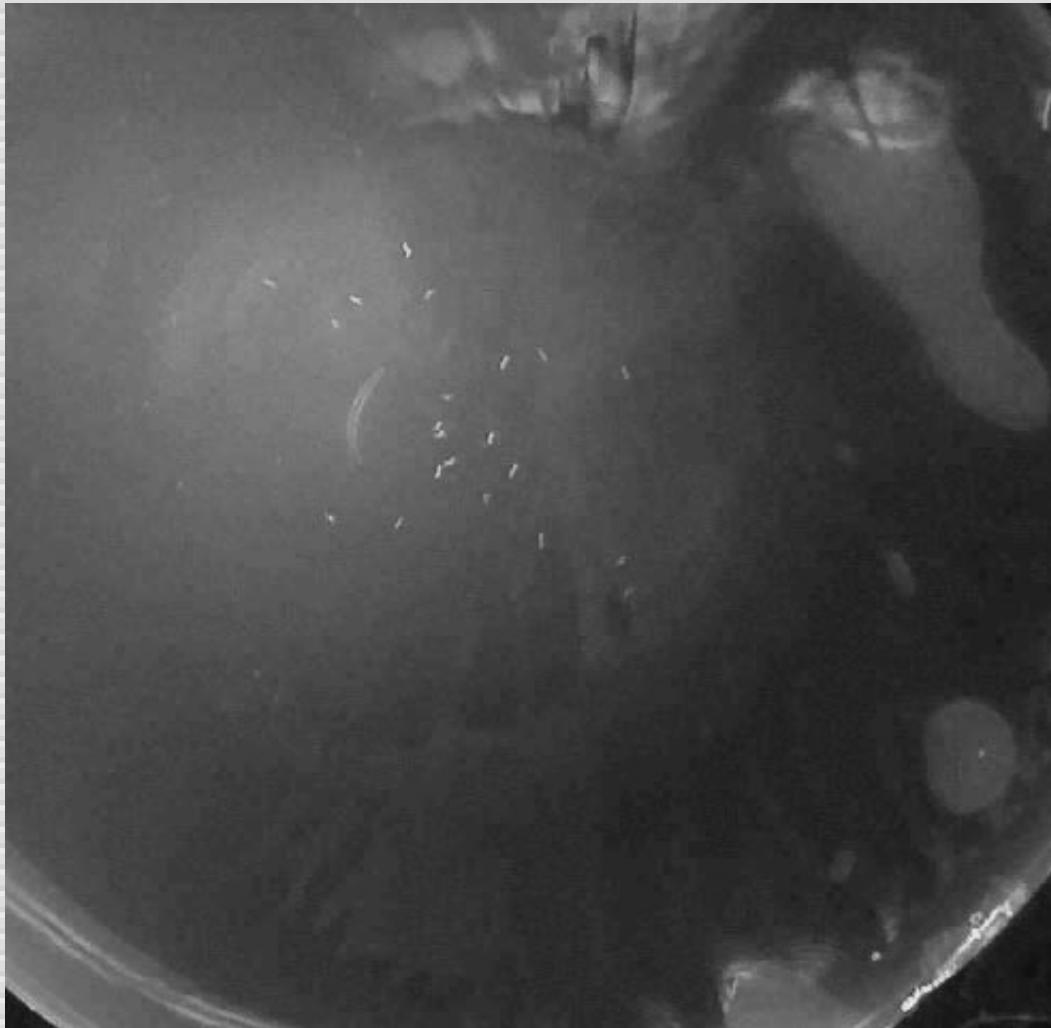
# *Nanoneurosurgery*

## *Caenorhabditis Elegans*

- ▶ **80 µm x 1 mm**
- ▶ **about 1300 cells**
- ▶ **302 neurons**
- ▶ **invariant wiring diagram**
- ▶ **neuronal system completely encodes behavior**

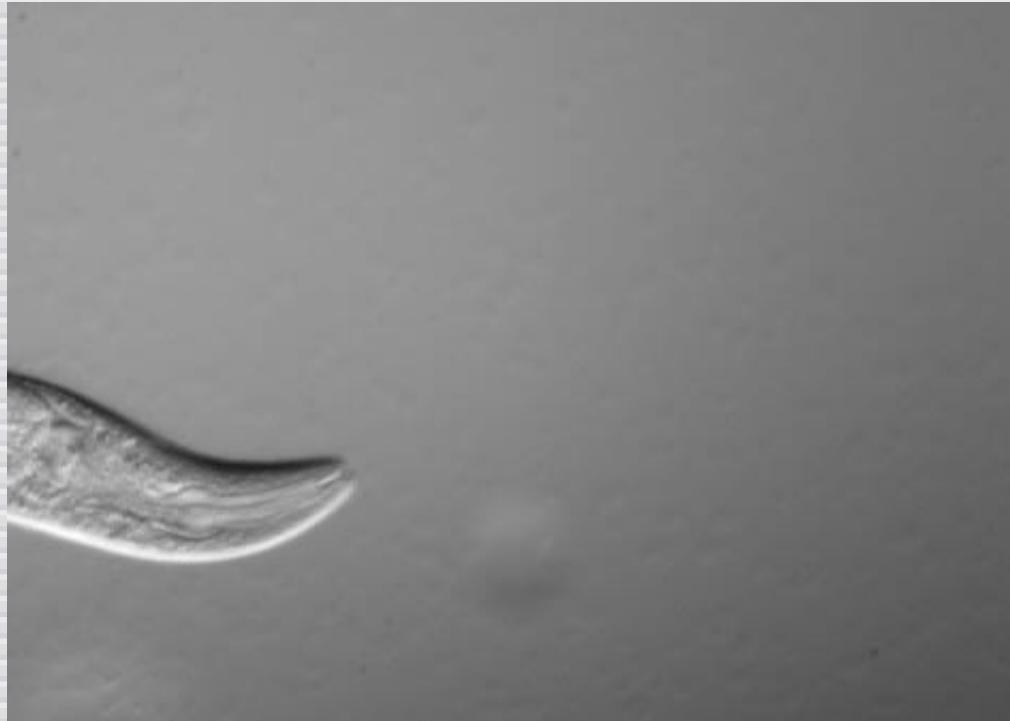
# *Nanoneurosurgery*

## *Caenorhabditis Elegans*



*Nanoneurosurgery*

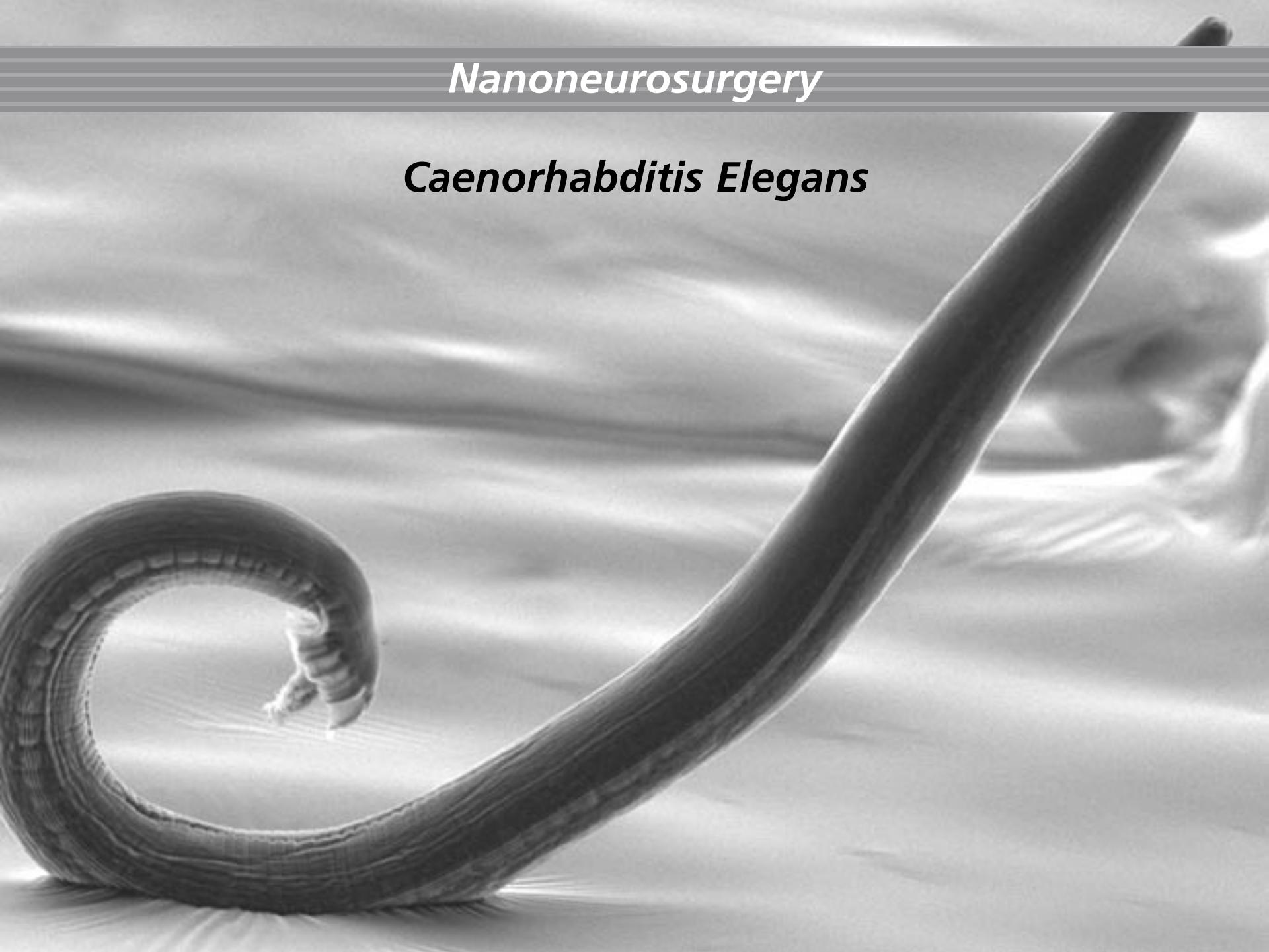
*Caenorhabditis Elegans*



**Bob Goldstein, UNC Chapel Hill**

*Nanoneurosurgery*

***Caenorhabditis Elegans***





# *Nanoneurosurgery*



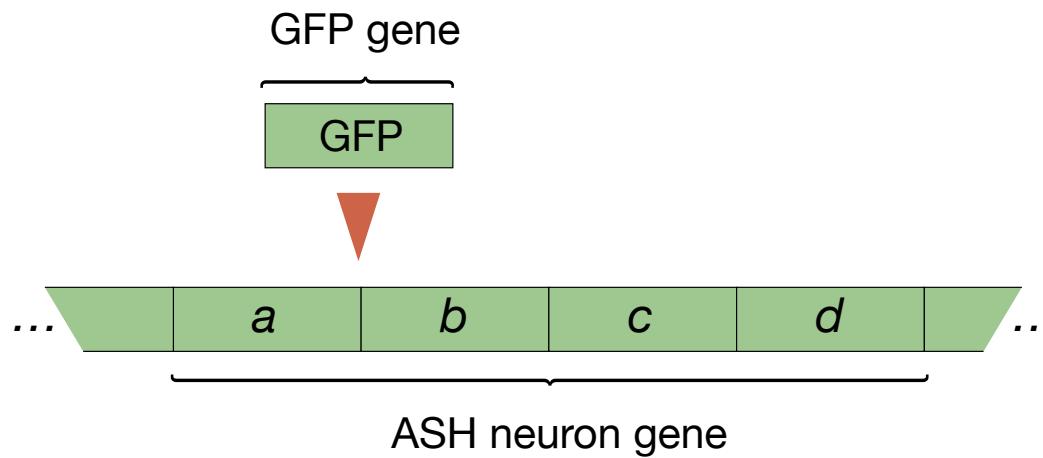
# *Nanoneurosurgery*

## ASH neurons

- ▶ **responsible for osmotic avoidance**
- ▶ **ciliary projections extend through skin**
- ▶ **one on each side**

# *Nanoneurosurgery*

**make ASH neurons express GFP**



# *Nanoneurosurgery*

**GFP: absorbs UV, emits green**

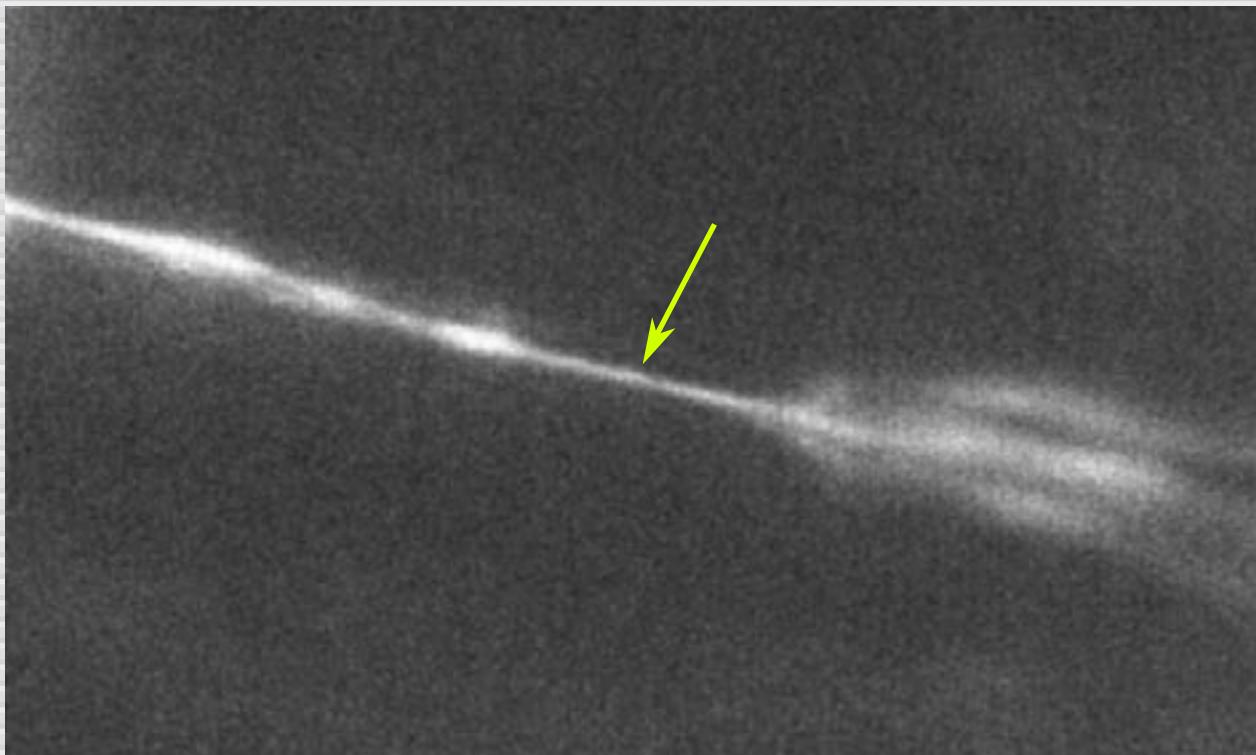


**Manual**

**1-10-00 2H  
16:42:28 1/60**

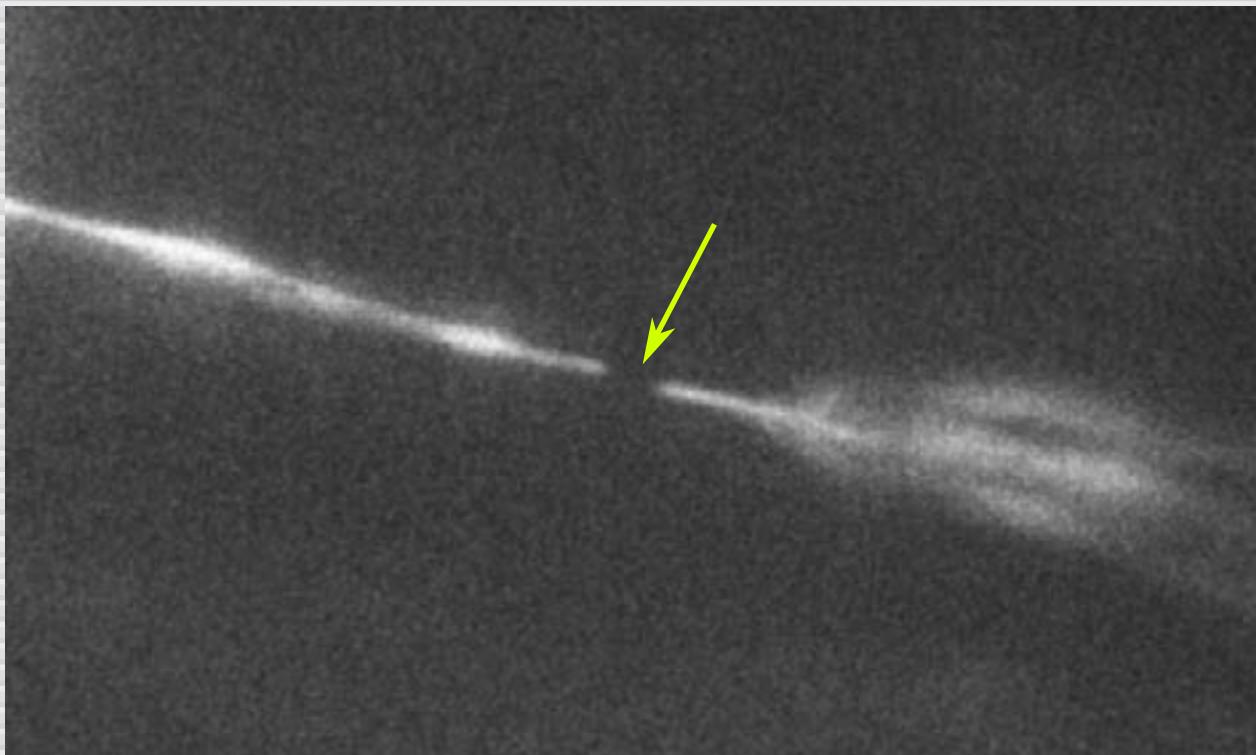
# *Nanoneurosurgery*

**cutting an axon**



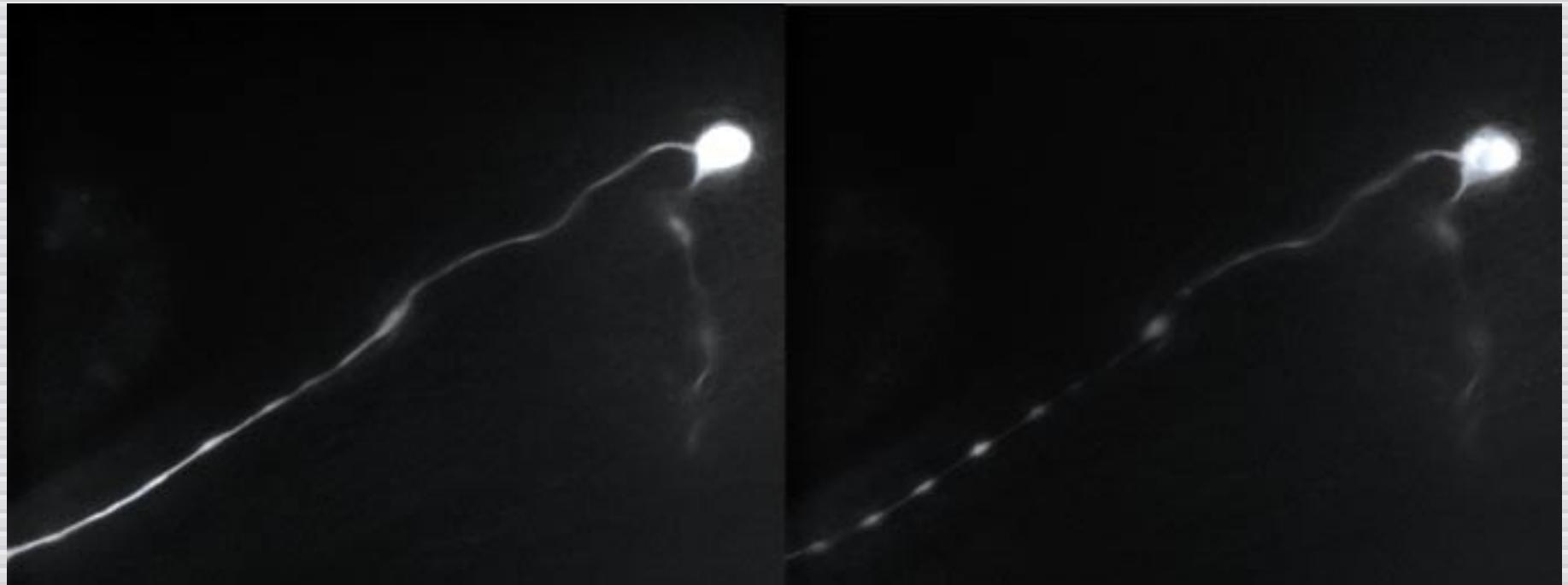
# *Nanoneurosurgery*

**cutting an axon**



*Nanoneurosurgery*

**pearling instability**



## *Conclusion*

- ▶ **wiring optoelectronics circuits of the future**
- ▶ **manipulating the machinery of life**

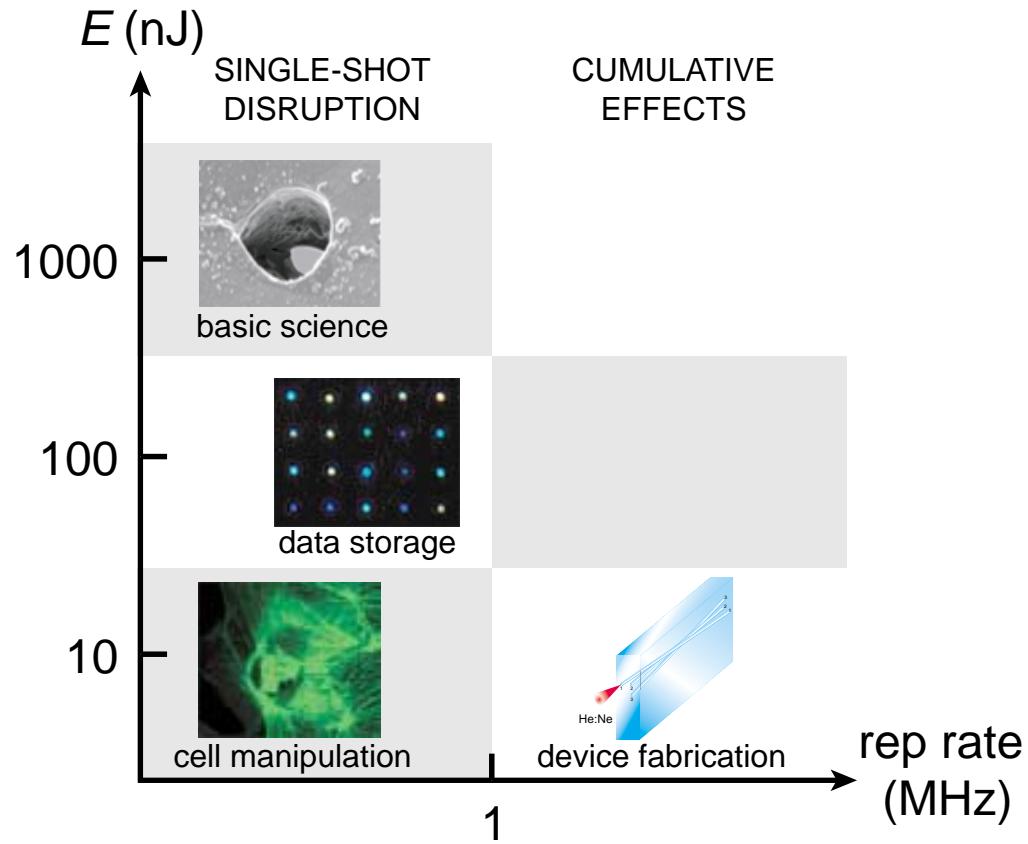
# *Summary*

## **important parameters**

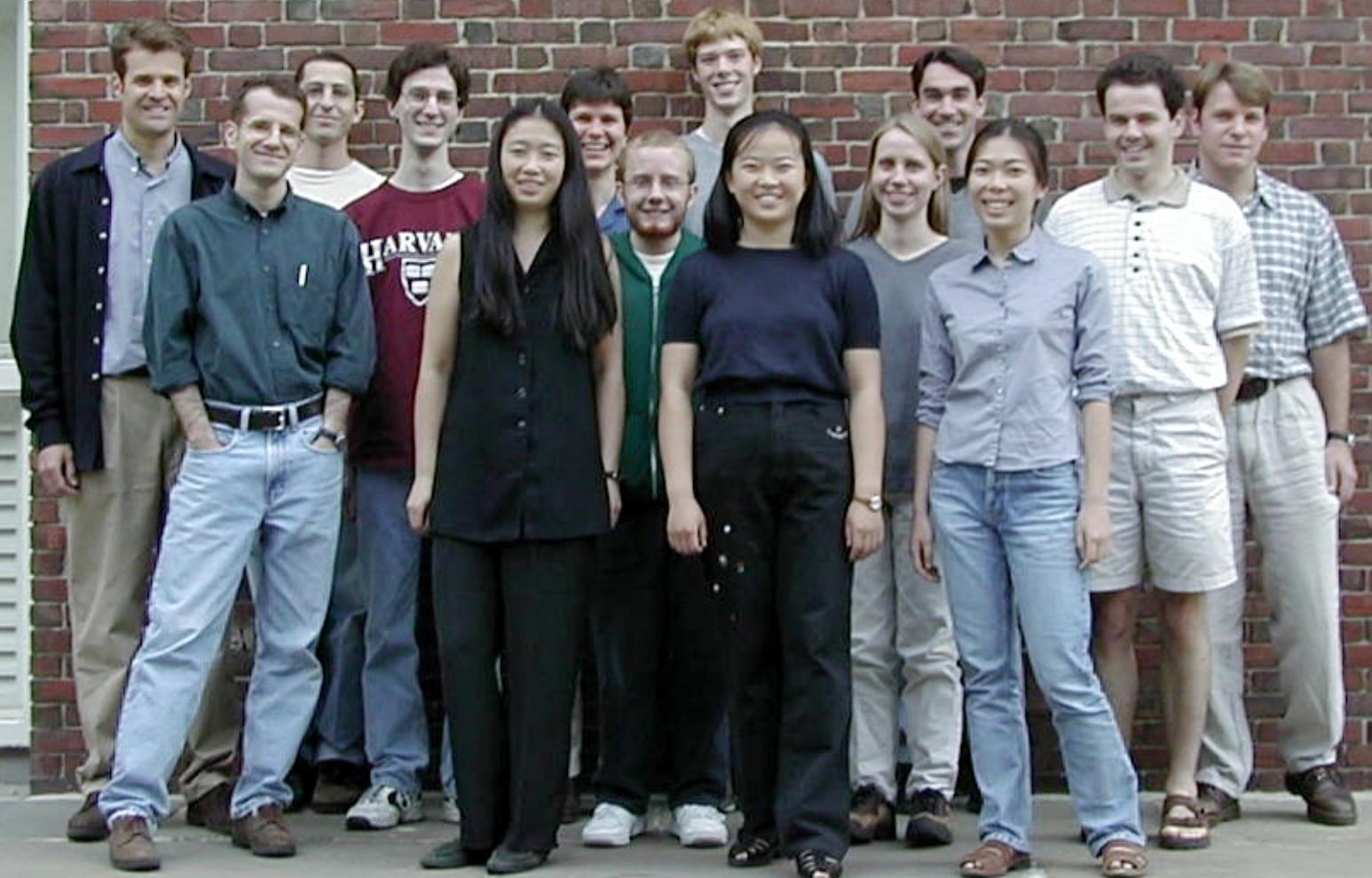
- ▶ **focusing**
- ▶ **energy**
- ▶ **repetition rate**

**nearly material-independent!**

# Summary



GORDON MCKAY  
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APPLIED SCIENCE



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**Yossi Chai (Sagitta, Inc.)**

**For a copy of this talk and  
additional information, see:**

**<http://mazur-www.harvard.edu>**

## *Processing with fs pulses*

100 nm

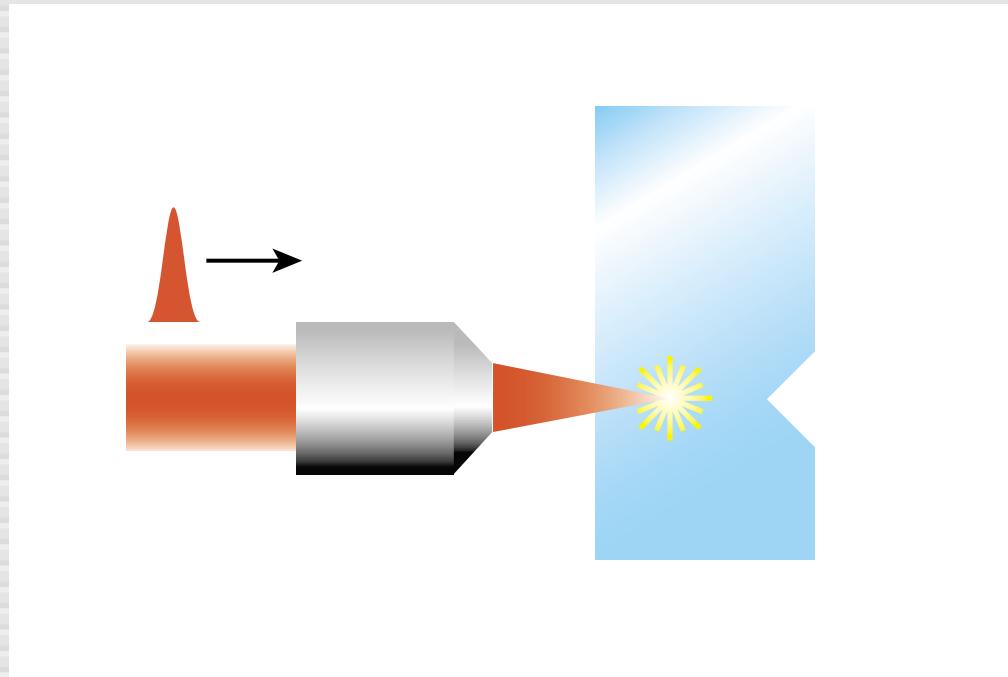
**5 x 5  $\mu\text{m}$  array**

**fused silica, 0.65 NA**

**0.5  $\mu\text{J}$ , 100 fs, 800 nm**

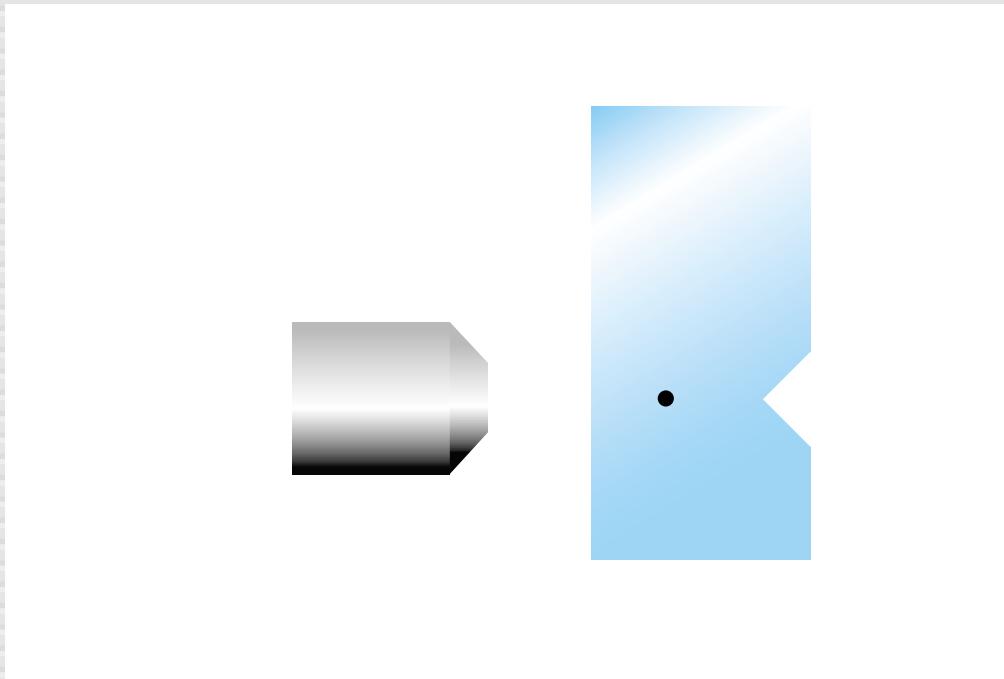
*Opt. Lett.* 21, 2023 (1996)

## *Processing with fs pulses*



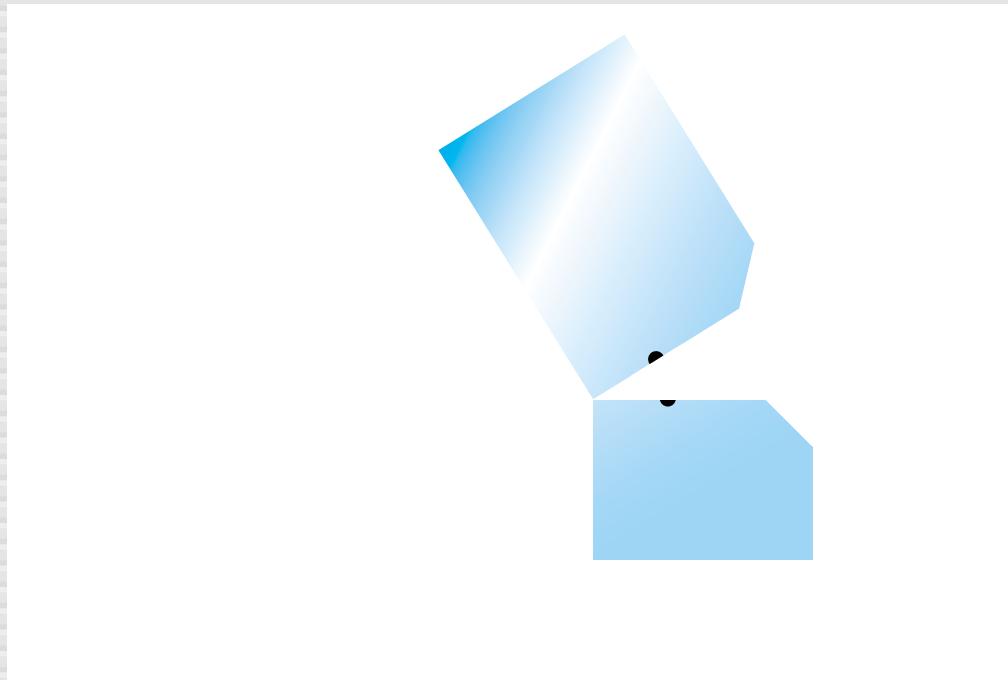
**microstructure scribed sample**

# *Processing with fs pulses*



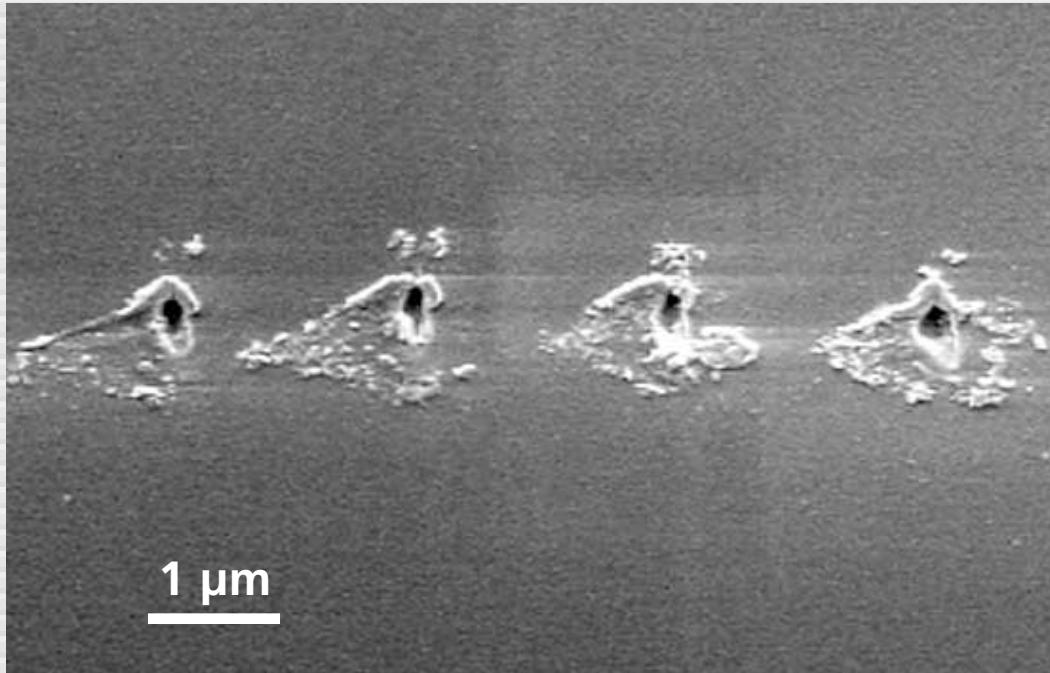
**microstructure scribed sample**

## *Processing with fs pulses*



**fracture along scribe line**

## *Processing with fs pulses*



**Corning 0211  
1.4 NA, 140 nJ**